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## INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(51) International Patent Classification <sup>6</sup> :		A1	(11) International Publication Number: <b>WO 95/22205</b> (43) International Publication Date: 17 August 1995 (17.08.95)
(21) International Application Number: PCT/US95/01554		(81) Designated States: JP, European patent (AT, BE, CH, DE, DK, ES, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE).	
(22) International Filing Date: 7 February 1995 (07.02.95)		Published <i>With international search report. Before the expiration of the time limit for amending the claims and to be republished in the event of the receipt of amendments.</i>	
(30) Priority Data: 08/196,914 15 February 1994 (15.02.94) US 08/222,138 1 April 1994 (01.04.94) US			
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(54) Title: TILE BASED ARCHITECTURE FOR FPGA			
<p><b>(57) Abstract</b></p> <p>An FPGA architecture offers logic elements with direct connection to neighboring logic elements and indirect connection through a routing matrix. A logic element and a portion of the routing matrix are formed as part of a tile, and tiles are joined to form arrays of selectable size. The routing matrix includes routing lines which connect just from one tile to the next and routing lines which extend longer distances through several tiles or through the entire chip. This combination is achieved by the formation of individual tiles, all of which are identical.</p>			
<img alt="Diagram of the Tile-Based Architecture for FPGA. The diagram shows a central 'Programmable Routing Matrix' (201) and a 'Configurable Logic Block Matrix' (202). The routing matrix is a grid of lines connecting various logic blocks. The logic blocks are represented by rectangles with internal connections. Inputs and outputs are labeled around the perimeter, including D0, D1, D2, D3, D4, D5, D6, D7, D8, D9, D10, D11, D12, D13, D14, D15, D16, D17, D18, D19, D20, D21, D22, D23, D24, D25, D26, D27, D28, D29, D30, D31, D32, D33, D34, D35, D36, D37, D38, D39, D40, D41, D42, D43, D44, D45, D46, D47, D48, D49, D50, D51, D52, D53, D54, D55, D56, D57, D58, D59, D60, D61, D62, D63, D64, D65, D66, D67, D68, D69, D70, D71, D72, D73, D74, D75, D76, D77, D78, D79, D80, D81, D82, D83, D84, D85, D86, D87, D88, D89, D90, D91, D92, D93, D94, D95, D96, D97, D98, D99, D100, D101, D102, D103, D104, D105, D106, D107, D108, D109, D110, D111, D112, D113, D114, D115, D116, D117, D118, D119, D120, D121, D122, D123, D124, D125, D126, D127, D128, D129, D130, D131, D132, D133, D134, D135, D136, D137, D138, D139, D140, D141, D142, D143, D144, D145, D146, D147, D148, D149, D150, D151, D152, D153, D154, D155, D156, D157, D158, D159, D160, D161, D162, D163, D164, D165, D166, D167, D168, D169, D170, D171, D172, D173, 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## TITLE BASED ARCHITECTURE FOR FPGA

6 FIELD OF THE INVENTION

7       The invention relates to programmable logic devices  
8 formed in integrated circuits and more particularly to an  
9 architecture of a programmable logic device in which logic  
10 blocks are provided in a repeating pattern.

11

12 BACKGROUND OF THE INVENTION

13       Field programmable gate arrays (FPGAs) are well known in  
14 the art. An FPGA comprises an array of configurable logic  
15 blocks (CLBs) which are programmably interconnected to each  
16 other to provide a logic function desired by a user. U.S.  
17 Patent 4,870,302, reissued as U.S. Patent Re.34,363, and  
18 incorporated herein by reference, describes a well known FPGA  
19 architecture. Other publications, such as U.S. Patent  
20 4,758,745, U.S. Patent 5,243,238, and published application WO  
21 93/05577, also incorporated herein by reference, describe  
22 other FPGA architectures. The Xilinx 1993 Data Book entitled  
23 "The Programmable Logic Data Book", available from Xilinx,  
24 Inc., 2100 Logic Drive, San Jose, California 95124, also  
25 incorporated herein by reference, describes several products  
26 which implement a number of FPGA architectures.

27       An FPGA is considered to be a general purpose device,  
28 i.e. being capable of performing any one of a plurality of  
29 functions, and is programmed by an end user to perform a  
30 selected function. Because of this design flexibility, a  
31 general purpose FPGA includes a significant number of wiring  
32 lines and transistors which remain unused in most  
33 applications. Moreover, FPGAs include overhead devices which  
34 facilitate programming of the FPGA to do the specified  
35 function. These overhead devices undesirably add area to the  
36 FPGA chip. To compensate for this overhead, it is  
37 commercially important to reduce the cost of the FPGA. One  
38 way to reduce the cost is to make the FPGA less general  
39 purpose, that is, to eliminate some configuration options  
40 which are less commonly used. However, this reduction in

1 configuration options reduces the value of the FPGA to.  
2 customers, who may not be able to predict which options will  
3 be needed. Therefore, a need arises to eliminate area while  
4 maximizing configuration options.

5

6 SUMMARY OF THE INVENTION

7 In accordance with the present invention, a field  
8 programmable gate array (FPGA) architecture includes  
9 repeatable tiles. Each tile comprises a programmable routing  
10 matrix and a configurable logic block matrix. The  
11 configurable logic block matrix is programmably connectable to  
12 the programmable routing matrix, as well as to the  
13 configurable logic block matrices in adjacent tiles. The  
14 programmable routing matrix is programmably connectable to the  
15 programmable routing matrices adjacent to the tile, as well as  
16 to long lines which extend across the tile. Thus, each tile  
17 provides a combination of logic, connection to nearby tiles,  
18 and connection to a general routing structure. A plurality of  
19 these tiles are joined together to form an array of tiles  
20 which make up the functional portion of an FPGA chip. With  
21 this architecture, devices of different sizes are produced by  
22 simply joining together different numbers of tiles, thereby  
23 eliminating an expensive and time consuming design effort.  
24 Moreover, in accordance with the present invention, the  
25 programmable routing matrix and configurable logic block  
26 matrix minimize the number of programmable interconnection  
27 points (PIPs), thereby reducing expensive chip area and  
28 maximizing density of the entire chip. In further accordance  
29 with the present invention, proper positioning of the PIPs  
30 ensures the necessary routing flexibility, thereby maximizing  
31 functionality of the FPGA.

32 A tile architecture has a set of signal lines exiting the  
33 tile at the boundaries. Thus, for example, signal lines  
34 exiting at the right of one tile connect with signal lines  
35 exiting at the left of another tile. In one embodiment,  
36 adjacent tiles are identical, forming a repeating pattern. In  
37 another embodiment, adjacent tiles are not identical but have

1 signal lines at least most of which match at the tile  
2 boundaries. Thus, a chip can be formed as an array of modular  
3 units which match at their boundaries, and additional  
4 flexibility of designing tiles for use in a plurality of chip  
5 designs is easily available.

6

7 BRIEF DESCRIPTION OF THE DRAWINGS

8 Fig. 1 shows an FPGA chip which includes components  
9 according to the present invention.

10 Fig. 2A shows a single core tile which populates a  
11 majority of the FPGA chip illustrated in Fig. 1.

12 Fig. 2B shows four adjacent core tiles of the type  
13 illustrated in Fig. 2A.

14 Fig. 3A illustrates a configurable logic block matrix  
15 which is part of the tile of Fig. 2A.

16 Fig. 3B illustrates a multiplexer structure which  
17 implements all PIPs which connect the output lines of a  
18 configurable logic block to one output line.

19 Fig. 3C shows one embodiment of a multiplexer structure  
20 which drives a configurable logic block input line.

21 Fig. 4C illustrates the configurable logic block in the  
22 matrix of Fig. 3A.

23 Fig. 4B illustrates tri-state buffer block 302 of Fig.  
24 3A.

25 Fig. 4C illustrates the output enable block 309 of Fig.  
26 3A.

27 Fig. 4D shows a look up table embodiment of the F, G, H  
28 and J function generators of Fig. 4A.

29 Fig. 4E shows another look up table embodiment of the F,  
30 G, H and J function generators of Fig. 4A.

31 Fig. 4F shows one Karnaugh map for the look up table  
32 function generator of Fig. 4D or 4E.

33 Fig. 4G shows one of the  $2^{16}$  logic functions which can be  
34 implemented by the look up table function generator of Fig. 4D  
35 or 4E.

36 Figs. 5A-5C illustrate application of the configurable  
37 logic block of Fig. 4A to form a carry chain, a cascadable

1 decode circuit, and two 5-input combinational functions,  
2 respectively.

3 Fig. 6 illustrates the programmable routing matrix of  
4 Fig. 2A.

5 Fig. 7A illustrates an example of the connectivity  
6 achieved by a programmable routing matrix of the invention  
7 such as shown in Fig. 6.

8 Fig. 7B illustrates an example of the connectivity  
9 achieved by the combination of the programmable routing matrix  
10 of Fig. 6 and the tile structure of Fig. 2A or 2B.

11 Fig. 8 illustrates connections from global signal pads  
12 near corners of a chip to global signal lines which extend  
13 near four edges of the chip and connect to global lines which  
14 drive core tiles.

15 Fig. 9 illustrates long line splitters which are provided  
16 on long lines in one embodiment of the invention.

17 Figs. 10A-10D illustrate, respectively, left, top, right,  
18 and bottom edge tiles according to one embodiment of the  
19 invention.

20 Figs. 11A-11D illustrate upper left, upper right, lower  
21 right, and lower left corner tiles for the same embodiment.

22 Fig. 12 illustrated a logic diagram for one embodiment of  
23 the oscillator structure used in Fig. 11B.  
24

#### 25 DETAILED DESCRIPTION OF THE DRAWINGS

26 The following drawing conventions are used throughout the  
27 figures. A small solid black dot at the intersections of two  
28 lines indicates a permanent electrical connection between the  
29 crossing lines. An open circle enclosing an intersection  
30 between two lines indicates a programmable connection between  
31 the lines (for example, a pass transistor which is turned on  
32 to make the connection). Open circles represent bidirectional  
33 signal flow between the two lines. An open triangle at an  
34 intersection of two lines indicates a programmable connection  
35 with signal flow going onto the line pointed to by the apex of  
36 the triangle. (The signal is of course then present on the  
37 full length of the line. Thus, a triangle pointing in the

1 opposite direction would have the same signal flow because the  
2 triangle points to the same wire.) In accordance with one  
3 embodiment of the present invention, programmable connections  
4 are provided by using programmable interconnection points  
5 (PIPs), wherein each PIP includes at least one transistor.

6 A triangle on a line which is not intersected by another  
7 line indicates a buffer which produces signal flow in the  
8 direction indicated by the apex of the triangle. Except for  
9 global lines ENOUT and ENLL (illustrated in Fig. 3A), a line  
10 which ends within the tile or matrix structure (i.e. does not  
11 extend to the border of a tile or matrix) is physically  
12 terminated within the tile. A line which extends to the  
13 border of the tile or matrix connects to a line on the next  
14 tile, which it contacts when two tiles are abutted together.  
15 Note that some lines which extend to an edge of a tile and  
16 thus into an adjacent tile change names at the tile boundary.  
17 Lines in the configurable logic block matrix and the  
18 programmable routing matrix are given the same reference  
19 numeral to indicate these lines are physically connected to  
20 each other.

21 Fig. 1 shows an FPGA chip 100 according to the present  
22 invention. In the center portion of chip 100 are a plurality  
23 of identical core tiles 101, which are interconnected by  
24 conductive lines (described in detail below). Along the four  
25 edges of chip 100 are west, north, east, and south edge tiles  
26 103, 104, 105, 106, respectively. In the four corners of the  
27 chip are four corner tiles 113, 114, 115, and 116. Chip 100  
28 includes pads, i.e. pads P1-P56, for connecting edge tiles  
29 103, 104, 105, 106, and corner tiles 113-116 to external pins  
30 of a package (which holds chip 100). Note that each edge tile  
31 is further connected to a core tile 101. As shown in Fig. 1,  
32 edge tiles are connected to different numbers of pads P,  
33 typically from zero to four pads (explained in detail in  
34 reference to Figs. 10a-10d). Fig. 1 also illustrates high  
35 voltage source pads VCC and low voltage source pads GND.  
36 Power and ground connections (not shown) are provided in a  
37 conventional manner throughout chip 100.

1       Fig. 2A shows a core tile 101. Core tile 101 includes a  
2 programmable routing matrix 201 and a configurable logic block  
3 matrix 202. Programmable routing matrix 201 is described in  
4 detail in reference to Fig. 6, whereas configurable logic  
5 block matrix 201 is described in detail in reference to Fig.  
6 3A.

7       Extending to the west from programmable routing matrix  
8 201 are twelve lines with suffixes 0 through 11. These  
9 include single length west lines W1-W5, W7-W11, and double  
10 length west lines DW0 and DW6 (described in detail below).  
11 Extending to the north from programmable routing matrix 201  
12 are single length north lines N1-N5, N7-N11 and double length  
13 north lines DN0 and DN6. Extending to the east are single  
14 length east lines E1-E5 and E7-E11 and double length east  
15 lines DE0 and DE6. Extending to the south are single length  
16 south lines S1-S5 and S7-S11 and double length south lines DS0  
17 and DS6. Extending east to west across tile 101 are double  
18 length horizontal lines DH0 and DH6. Extending north to south  
19 across tile 101 are double length vertical lines DV0 and DV6.

20      Fig. 2B shows four adjacent core tiles 101a, 101b, 101c  
21 and 101d having a configuration identical to tile 101  
22 illustrated in Fig. 2A. For clarity in Fig. 2B, most lines  
23 are not labeled. As mentioned previously, lines extending to  
24 the edges of tile 101 connect to lines in adjacent tiles. For  
25 example, single length west line W1b in tile 101b extending to  
26 the west from programmable routing matrix 201b connects to  
27 single length east line E1a in adjacent tile 101a. Double  
28 length horizontal line DH6a of tile 101a is coupled to double  
29 length west line DW6b of tile 101b, and is further coupled to  
30 a double length east line DE6 of a tile not shown in Fig. 2B  
31 but which is located directly west of tile 101a (hence the  
32 terminology "double length"). Line Q0c extending east from  
33 CLB matrix 202c in tile 101c connects to line QW0d extending  
34 west from CLB matrix 202d in tile 101d. Fig. 2B also  
35 illustrates that horizontal global lines GH0 and GH1 and  
36 vertical global lines GV0 and GV1 extend continuously from one  
37 tile 101 to the next. These global lines may be connected to

1 a common line at the edge of the tile so that a signal on a  
2 global line such as GH0 extends through all tiles. As shown  
3 in Fig. 2B, vertical global lines GV0 and GV1 and horizontal  
4 global lines GH0 and GH1 are coupled to both programmable  
5 routing matrix 201 and configurable logic block matrix 202.

6 Returning to Fig. 2A, configurable logic block (CLB)  
7 matrix 202 is connected to the CLB matrix in the west tile  
8 (not shown) by output lines Q0-Q3 and input lines QW0-QW3, to  
9 the CLB matrix in the north tile (not shown) by output lines  
10 Q0-Q3 and input lines QN0-QN3, to the CLB matrix in the east  
11 by output lines Q0-Q3 and input lines QE0-QE3, and to the CLB  
12 matrix in the south tile (not shown) by output lines Q0-Q3 and  
13 input lines QS0-QS3. Note that output lines Q0-Q3 carry the  
14 same signals from CLB matrix 202 to adjacent tiles in four  
15 directions and thus have the same names. Carry-in line CIN  
16 and carry-out line COUT, which extend vertically in tile 101,  
17 connect to carry-out and carry-in lines, respectively, in  
18 adjacent tiles to form a fast carry path for arithmetic  
19 functions, as discussed in detail in U.S. Patent No.  
20 5,349,250, "LOGIC STRUCTURE AND CIRCUIT FOR FAST CARRY", which  
21 is incorporated herein by reference.

22

### 23 Configurable Logic Block Matrix 202

24 Fig. 3A illustrates configurable logic block (CLB) matrix  
25 202 of Fig. 2a. CLB matrix 202 includes a CLB 301, a tristate  
26 buffer block 302, an input interconnect structure 303, a CLB  
27 output interconnect structure 304, a feedback interconnect  
28 structure 305, a general input interconnect structure 306, a  
29 register control interconnect structure 307, an output  
30 interconnect structure 308, and an output enable block 309.

31

### 32 Sparse Pipulation

33 Programmable connections are provided by using  
34 programmable interconnection points (PIPs), wherein each PIP  
35 includes at least one transistor. As is well known in the  
36 art, each transistor occupies valuable space on the chip

1 substrate. Thus, in accordance with the present invention and  
2 referring to Fig. 3A, a majority of the horizontal and  
3 vertical lines in input interconnect structure 303, feedback  
4 interconnect structure 305, general input interconnect  
5 structure 306, and register control interconnect structure 307  
6 are not programmably connectable. In other words, these  
7 structures are sparsely populated with PIPs, or are sparsely  
8 "pipulated". Sparse pipulation minimizes chip area used by  
9 PIPs, thereby maximizing density of the entire chip. In  
10 further accordance with the present invention, proper  
11 positioning of the PIPs significantly increases routing  
12 flexibility, thereby effectively compensating for the reduced  
13 number of PIPs in the interconnect structures.

14 For example, referring to input interconnect structure  
15 303, PIPs are positioned to allow connection from each output  
16 line Q0-Q3 from CLB output interconnect structure 304 to one  
17 of the function generators F, G, H, or J of an adjacent tile  
18 in each of the four compass directions. In this embodiment,  
19 general input interconnect structure 306 provides four to six  
20 PIPs for each CLB input line (J0-J3, JB, H0-H3, HB, G0-G3, GB,  
21 F0-F3 and FB) to CLB 301. Feedback interconnect structure 305  
22 provides direct connections from two of output lines Q0-Q3 to  
23 one of the function generator input terminals in CLB 301. As  
24 shown in Fig. 3A, 24 PIPs in output interconnect structure 308  
25 connect output lines Q0-Q7 to tile interconnect lines M0-M23.  
26 In this manner, signals on tile interconnect lines M0-M23 are  
27 selectively transferred between CLB 301 and programmable  
28 routing matrix 201 (via CLB output interconnect structure 304,  
29 general input interconnect structure 306, and output  
30 interconnect structure 308). In this embodiment, less than  
31 one intersection in eight is provided with a PIP, thereby  
32 minimizing silicon area. Yet, connectivity from any output  
33 line to any input line is ensured by the PIPs provided.  
34

35 Configurable Logic Block 301

36 A configurable logic block (CLB) 301 is illustrated in  
37 Fig. 4A. In this embodiment, CLB 301 includes four function

1 generators F, G, H, and J, wherein each function generator  
2 comprises a 16-bit look up table that generates an output  
3 signal determined by the four input signals provided to the  
4 function generator and the values stored in the look up table.  
5 Thus, function generator F generates an output signal  
6 determined by the input signals provided on lines F0-F3,  
7 function generator G generates an output signal determined by  
8 the signals provided on CLB input lines G0-G3, function  
9 generator H generates an output signal determined by the  
10 signals provided on CLB input lines H0-H3, and function  
11 generator J generates an output signal determined by the  
12 signals provided on CLB input lines J0-J3.

13

14 Look Up Table

15 Operation of the look up table function generators will  
16 be described in connection with Figs. 4D-4G. These figures  
17 were first discussed by Freeman in U.S. Patent 4,870,302 now  
18 reissued as U.S. Patent Re 34,363, incorporated herein by  
19 reference.

20 Fig. 4D illustrates a look up table, in this embodiment a  
21 16-bit RAM, which provides an output signal in response to any  
22 one of sixteen possible combinations of four input signals.  
23 Specifically, input signals A and B control the X decoder to  
24 select any one of the four columns in the 16-bit RAM. In a  
25 similar manner, input signals C and D control the Y decoder to  
26 select any one of the four rows in the 16-bit RAM. The 16-bit  
27 RAM provides an output signal representative of the bit at the  
28 intersection of the selected row and the selected column.  
29 There are 16 such intersections and thus sixteen such bits.  
30 It logically follows that 16 bits provide  $2^{16}$  possible  
31 combinations. Thus, if a 4-input NOR gate is to be simulated  
32 by the 16 bit RAM, the Karnaugh map for the look up table  
33 would be as shown in Fig. 4F. In Fig. 4F, all bits are "0"  
34 except the bit at the intersection of the first row  
35 (representing A=0, B=0) and the first column (representing  
36 C=0, D=0). If a logic "1" output signal is desired for A=1,  
37 B=0, C=0, D=0, then a logic "1" is stored at the intersection

1 of the second row and the first column. If a logic "1" is  
2 desired for A=0, B=0, C=0, and D=0 and also for A=1, B=0, C=0  
3 and D=0, then a logic "1" is stored at each of the  
4 intersections of the first column with the first row and the  
5 second row. The logic circuit represented by this loading of  
6 the look up table is shown in Fig. 4G. Thus, the look up  
7 table of Fig. 4D represents an elegant and simple  
8 implementation of any one of  $2^{16}$  logic functions.

9 Fig. 4E shows a register configuration for yielding any  
10 one of sixteen select bits. Each of registers 0-15 in the  
11 vertical column to the left labeled "16 Select Bits", contains  
12 a selected signal, either a logic 1 or 0. By selecting the  
13 appropriate combination of signals A, B, C, and D and their  
14 complements, a particular bit stored in a particular one of  
15 the sixteen locations in the 16 Select Bits register is  
16 transmitted to the output lead OUT. Thus, for example, to  
17 transmit the bit in the "1" register to the output lead, the  
18 signal A, B, C, D is applied to the leads so labeled. To  
19 transmit the signal labeled "15" in the sixteenth location in  
20 the 16 Select Bits register to the output lead, the signal A,  
21  $\bar{B}$ ,  $\bar{C}$ ,  $\bar{D}$  is applied to the appropriate columns. Thus, this  
22 register configuration also provides any one of  $2^{16}$  logic  
23 functions.

24 Referring back to Fig. 4A, the memory bits in look up  
25 tables F, G, H and J are typically loaded during configuration  
26 of the chip, for example through a shift register, or  
27 alternatively by an addressing means. In some embodiments,  
28 the memory bits are also loaded during operation of the chip,  
29 thereby reconfiguring the chip on the fly. A reconfigurable  
30 memory structure is discussed in commonly assigned, U. S.  
31 Patent No. 5,343,406 invented by Freeman et al. and entitled  
32 "Distributed Memory Architecture for a Configurable Logic  
33 Array and Method for Using Distributed Memory", which is  
34 incorporated herein by reference.

35 Function generators F, G, H, and J provide output signals  
36 on CLB output lines X, Y, Z, and V, respectively. These  
37

1 output signals from function generators F, G, H, and J control  
2 multiplexers C1, C2, C3, and C4, thereby providing a  
3 cumulative carry-out function COUT. Multiplexer C1 receives a  
4 carry-in signal on line CIN and an input signal on line FB,  
5 and generates an output signal on line CF. Multiplexer C2  
6 receives the signal on line CF and an input signal on line GB,  
7 and generates an output signal on line CG. Multiplexers C3  
8 and C4 are connected in the same manner as Multiplexers C1 and  
9 C2. Multiplexer C4 provides an output signal on line COUT  
10 from CLB 301. For a detailed discussion of the implementation  
11 of arithmetic functions, see commonly assigned U.S. Patent No.  
12 5,349,250 invented by Bernard E. New, entitled "LOGIC  
13 STRUCTURE AND CIRCUIT FOR FAST CARRY", which is incorporated  
14 herein by reference.

15 In addition to function generators F, G, H, and J, each  
16 CLB 301 includes four storage devices RX, RY, RZ, and RV.  
17 These storage devices RX, RY, RZ, and RV each comprise flip  
18 flops with master and slave stages and an output multiplexer  
19 which takes outputs from the master and slave stages as  
20 inputs. Thus devices RX, RY, RZ, and RV can be configured by  
21 the multiplexer to serve as either flip flops or as latches.

22 Typically, periodic repowering of the carry signal is  
23 necessary. In this embodiment, to provide this repowering, a  
24 repowering buffer comprising inverters I121 and I122 is  
25 positioned every four multiplexers in the carry path, or once  
26 every CLB 301. In another embodiment, a repowering buffer is  
27 provided every two multiplexers in the carry path, thus two  
28 repowering buffers are provided in every CLB 301.

29 In this embodiment, CLB 301 includes five input lines per  
30 function generator. For example, referring to function  
31 generator F, CLB input lines F0-F3 provide input signals to  
32 function generator F, and a fifth CLB input line FB provides a  
33 multiplexer control input signal. Function generators G, H,  
34 and J are configured in a similar manner. Three input lines  
35 CLK, CE, and RST provide clock, clock enable, and reset  
36 signals, respectively, to registers RX, RY, RZ, and RV.

1        As shown in Fig. 4A, four groups of three output signals  
2    are provided from CLB 301, one group associated with each  
3    function generator. The three output signals include:

- 4        • a direct, unregistered output signal from the function  
5    generator (provided on CLB output lines X, Y, Z, or V),  
6        • an alternative, unregistered output signal which may be  
7    derived from one of the CLB input signals, a signal from  
8    the carry chain, or in two cases a signal from a  
9    multiplexer which provides an output signal of a five-  
10   input function (provided on CLB output lines XB, YB, ZB,  
11   or VB), and  
12        • a registered, output signal which may be loaded by the  
13   function generator or by one of the sources of the  
14   alternative output signal (provided on CLB output lines  
15   XQ, YQ, ZQ, or VQ).

16   For example, CLB output line X receives a direct unregistered  
17   output signal from function generator F. CLB output line XB  
18   receives either the signal on CLB input line FB or the output  
19   signal of multiplexer S1 (as determined by multiplexer B1),  
20   which in turn is derived from either the carry-out signal CF  
21   or the five-input function-generator output signal from  
22   multiplexer FG (see discussion of Fig. 5C below). CLB output  
23   line XQ receives the registered output signal from register  
24   RX, which derives its D input signal either directly from  
25   function generator F (the signal on output line X) or the  
26   alternative output signal on line XB as determined by  
27   multiplexer D1. Finally, output line K provides a constant  
28   signal, which may be high or low, as selected by multiplexer  
29   PG.

30       In the embodiment of Fig. 4A, multiplexers D1-D4  
31   selectively provide either the output signals from function  
32   generators F, G, H, and J (the same signals on CLB output  
33   lines X-V) or the output signals from multiplexers B1-B4 to  
34   registers RX-RV, respectively. If multiplexers S1 and S3 are  
35   set to forward the carry signals of multiplexers C1 and C3,  
36   respectively, then multiplexers B1-B4 select between the input

1 signals on CLB input lines FB-JB, respectively; and the output  
2 signals of multiplexers C1-C4.

3 Multiplexers C1-C4, in addition to being used for the  
4 carry function in an arithmetic operation, also generate wide  
5 AND and OR functions. To generate the AND function, a logic 0  
6 is placed on line FB to program multiplexer C1 to generate an  
7 AND function of the F function generator output signal on CLB  
8 output line X and the carry-in signal on line CIN.  
9 Alternatively, to generate the OR function, a logic 1 is  
10 placed on CLB input line FB to program multiplexer C1 to  
11 generate an OR function of the complement of the output signal  
12 on CLB output line X and the carry-in signal on line CIN.  
13 With a truth table architecture, the OR function is achieved  
14 by loading the inverse values into the truth table. The  
15 function of multiplexers C1-C4 and their interaction with the  
16 logic block are further discussed in application serial no.  
17 08/116,659 [M-2565] incorporated by reference.  
18

19 Example Applications of CLB 301

20 Figs. 5A-5C illustrate applications using CLB 301  
21 (described in detail in reference to Fig. 4A) to form a carry  
22 chain, a cascadable decode circuit and 2 five-input functions,  
23 respectively. These figures use heavy lines to illustrate  
24 lines of CLB 301 which are used for the particular selected  
25 function and thin dashed lines to indicate lines and elements  
26 not used for the particular function.

27 In Fig. 5A, CLB 301 is configured to compute a half sum  
28 H3H2H1H0 (where H3, H2, H1, and H0 are the four bits of a  
29 four-bit half-sum) and the carry bits C3C2C1C0 of two numbers  
30 A3A2A1A0 and B3B2B1B0. Another CLB (not shown), preferably  
31 positioned in the tile to the right or left of the one shown,  
32 will be used to complete the sum. Operands A3 and B3 are  
33 placed on any two of CLB input lines J0-J3. Operands A2 and  
34 B2 are placed on any two of CLB input lines H0-H3. A1 and B1  
35 are placed on any two of CLB input lines G0-G3. A0 and B0 are  
36 placed on any two of CLB input lines F0-F3. Unused lines are  
37 either held high or held low. Each of function generators F,

1 G, H, and J is loaded with the truth table of the XOR function  
2 (which is the half sum of its input signals). The truth table  
3 takes into account the values applied to unused input lines.  
4 If there are lower order bits than those applied to function  
5 generator F, the carry-out of those bits is placed on carry in  
6 line CIN. Multiplexers C1, C2, C3, and C4 are controlled by  
7 the output signals of function generators F, G, H and J,  
8 respectively. Specifically, if the function generator output  
9 signal is a logic 1 (signals A and B are not equal), the  
10 carry-in value is forwarded to the carry-out of that bit, and  
11 if the function generator output signal is a logic 0 (signals  
12 A and B are equal), the value of signal A or signal B is  
13 forwarded to the carry-out of that bit. Multiplexers B1-B4,  
14 S1 and S3 are controlled to forward the carry-out of each bit  
15 to the "B" CLB output line (i.e. CLB output lines XB, YB, ZB,  
16 and VB) of that bit. The function generator output signal for  
17 each bit (on CLB output lines X, Y, Z, and V) is provided as  
18 the half sum output for that bit.

19 In another application shown in Fig. 5B, CLB 301 is  
20 configured to operate as a cascadable decoder. A 16-bit  
21 address represented by signals A0-A15, is placed on CLB input  
22 lines F0-F3, G0-G3, and J0-J3. CLB input lines FB, GB, HB,  
23 and JB are grounded. The 16 bits of each of function  
24 generators F, G, H, and J include a single logic 1 to reflect  
25 a portion of a predetermined address. A logic 1 signal is  
26 placed on carry in line CIN. If all four function generators  
27 F, G, H, and J output their respective logic 1s (i.e.  
28 indicating an address "match"), then multiplexers C1-C4 all  
29 forward a logic 1 and produce a logic 1 signal on carry out  
30 line COUT.

31 In yet another application shown in Fig. 5C, CLB 301 is  
32 configured to generate two functions of five input signals  
33 each. Function generators F and G generate a first function  
34 of five input signals on CLB output line XB and function  
35 generators H and J generate a second function of five input  
36 signals on CLB output line ZB. For the first function, four  
37 input signals A0-A3 are provided on the CLB input lines to

1 both function generators F and G and the fifth input signal A4  
2 is provided to line FB. Input signal A4 causes multiplexer FG  
3 to select the output signal of function generator F or  
4 function generator G. In this embodiment, multiplexer S1 is  
5 programmed by its memory cell to select the output signal of  
6 multiplexer FG, and multiplexer B1 is programmed by its memory  
7 cell to select the output signal of multiplexer S1. Thus, the  
8 five-input function output signal from function generators F  
9 and G is provided on CLB output line XB. In a similar manner,  
10 the function of the five input signals B0-B4 provided to  
11 function generators H and J is generated on CLB output line  
12 ZB.

13 Loading the appropriate truth tables into the two  
14 associated function generators F and G produces the desired  
15 function of five input signals. Specifically, in one  
16 embodiment, a 32-bit look up table is stored in function  
17 generators F and G (i.e. two 16-bit look up tables). Thus, a  
18 large number of functions are alternatively provided by  
19 loading different values into the memory cells which form the  
20 truth tables of the function generators and control  
21 multiplexers FG and HJ.

22

### 23 Tristate Buffer 302

24 Fig 4B illustrates a schematic drawing of tri-state  
25 buffer block 302 (Fig. 3A) which includes tristate buffers B4-  
26 B7. Note that the line names are identical to those  
27 referenced in Fig. 3A. Output signals from AND gates A4-A7  
28 control tristate buffers B4-B7, respectively. If AND gate A5,  
29 for example, provides a logic 0 output signal, buffer B5 is  
30 enabled and provides a buffered output signal on line TQ5  
31 which matches its corresponding input signal on line Q5. On  
32 the other hand, if AND gate A5 provides a logic 1 output  
33 signal, buffer B5 is disabled and provides a high impedance  
34 at the output terminal. The output signals provided by AND  
35 gates A4-A7 are determined either globally by the output  
36 signal from OR gate OR1 or individually by memory cells  
37 MM4-MM7, respectively. If memory cells MM4-MM7 store logic

1 0's, then the output signals of AND gates A4-A7 will also be  
2 logic 0's regardless of the signal from OR gate OR1. OR gate  
3 OR1 provides a high output signal if the ENLL signal is low or  
4 if the signal on line TS is high. Referring back to Fig. 3A,  
5 the signal on tristate line TS is programmably selected from  
6 any of tile interconnect lines M16-M23.

7 The ENLL signal is a global signal provided to all  
8 buffers 302 in all tiles 101. The ENLL signal is held low  
9 during configuration and as other signals are being enabled  
10 after configuration in order to prevent contention which could  
11 result if various TS lines which are to connect input signals  
12 to the same long line are switching unpredictably during  
13 configuration.

14 If buffers B4-B7 are to be used during operation as  
15 repowering buffers (always enabled) for placing a signal onto  
16 a long line, memory cells MM4-MM7 are loaded with low values  
17 during configuration. This means that during configuration,  
18 AND gates A4-A7 will enable buffers B4-B7. However, no  
19 contention occurs because the input signals Q4-Q7 which drive  
20 signals TQ4-TQ7 onto long lines all carry a common signal  
21 during configuration, as will now be discussed in connection  
22 with Fig. 4C.

23

#### 24 Output Enable Block 309

25 The buffers in output enable block 309 are disabled  
26 during configuration of the device so that lines driven by  
27 these buffers will not experience contention. Fig. 4C  
28 illustrates the structure of block 309. Each buffer in output  
29 enable block 309 comprises a two-input AND gate. One input of  
30 each AND gate is driven by a global enable signal ENOUT. The  
31 other input is provided by a line Q0'-Q7' which is in turn  
32 provided by output signals from CLB 301 (Fig. 3A). During  
33 configuration, unexpected lines may be connected to these  
34 lines Q0-Q7. Therefore, to prevent contention, the ENOUT  
35 signal is held low during configuration so that all output  
36 signals on lines Q0-Q7 are low and unexpected connection of

1 other lines does not produce contention because all signals  
2 have a low value.

3

4 Neighbor Input Matrix 303

5 Referring back to Fig. 3A, in accordance with this  
6 embodiment of the present invention, adjacent CLBs 301 are not  
7 connected via direct connections, only via PIPs. For example,  
8 input signals are selectively provided to CLB 301 from input  
9 interconnect structure 303. Thus, each input line QS0-QS3 is  
10 connectable to one of the CLB input lines of one function  
11 generator. In this embodiment, line QS0 is connectable to CLB  
12 input line F1 of function generator F, line QS1 is connectable  
13 to CLB input line G1 of function generator G, line QS2 is  
14 connectable to CLB input line H1 of function generator H, and  
15 line QS3 is connectable to CLB input line J1 of function  
16 generator J. Because each function generator F, G, H or J is  
17 configurable to provide any function based on its input  
18 signals, a particular signal can be provided to any input  
19 terminal of a function generator and the look up table of that  
20 function generator loaded accordingly. Thus, it is not  
21 important which input signal is available to which function  
22 generator input terminal.

23 A signal on input line QW0 drives both CLB input lines F0

24 and FB. Similarly, a signal on input line QW1 drives CLB

25 input lines G0 and GB, a signal on input line QW2 drives CLB

26 input lines H0 and HB, and a signal on input line QW3 drives

27 CLB input lines J0 and JB. Each signal on input lines QE0,

28 QE1, QE2, and QE3 also drives two CLB input lines.

29 Specifically, a signal on input line QE0 drives CLB input

30 lines F1 and FB, a signal on input line QE1 drives lines G1

31 and GB, a signal on input line QE2 drives lines H1 and HB, and

32 a signal on input line QE3 drives lines J1 and JB.

33 Signals on input lines QN0-QN3 and QS0-QS3 each drive

34 only one CLB input line. Specifically, a signal on input line

35 QN0 drives CLB input line F0, a signal on input line QN1

36 drives CLB input line G0, a signal on line QN2 drives CLB

37 input line H0, and a signal on line QN3 drives CLB input line

1 J0. A signal on input line QS0 drives CLB input line F1, a  
2 signal on input line QS1 drives CLB input line G1, a signal on  
3 input line QS2 drives CLB input line H1, and a signal on input  
4 line QS3 drives CLB input line J1. This embodiment is  
5 particularly desirable for horizontal flow of many signals  
6 because each input line QE0-QE3 and QW0-QW3 is programmably  
7 connected to two CLB input lines. Other embodiments of the  
8 present invention, having a different number and positioning  
9 of programmable connections, are optimized for a different  
10 signal flows.

11

## 12 Output Matrix 304

13 CLB 301 provides output signals on CLB output lines X,  
14 XQ, XB, Y, YQ, YB, Z, ZQ, ZB, V, VQ, and VB. Note that CLB  
15 301 also determines whether it provides the signal on carry  
16 out line COUT or whether the signal on carry in line CIN is  
17 transferred to the next CLB in the tile above. PIPs on CLB  
18 output lines X, XQ, XB, Y, YQ, YB, Z, ZQ, ZB, V, VQ, VB, and K  
19 are selectively programmed to drive any number of output lines  
20 Q0-Q7 through a CLB interconnect structure 304. Note that CLB  
21 interconnect structure 304 is fully pipulated (i.e., any of  
22 the 13 output signals of CLB 301, excluding the signal on  
23 carry out line COUT, can drive any of output lines Q0-Q7).  
24 Note that interconnect structure 304 also buffers its output  
25 signals for driving further lines. Full pipulation of  
26 interconnect structure 304 requires 108 (13 x 8) PIPs. In  
27 contrast, structures 303, 305, 306, and 307 in combination use  
28 200 PIPs, even though they are sparsely pipulated.

29 Flexibility of CLB 301 to access a particular input signal  
30 from tile interconnect lines M0-M23 is ensured by:

- 31 •fully pipulating CLB output interconnect structure 304  
32 so that any CLB output signal can be provided to any of  
33 tile interconnect lines M0-M23;  
34 •pipulating programmable routing matrix 201 so that each  
35 line M0-M23 is connected to at least one line M0-M23 in  
36 each adjacent routing matrix 201 (see discussion of Fig.  
37 6 below);

- 1       •pipulating CLB matrix 202 so that each output line of
- 2       one CLB can be connected to at least one input line of
- 3       each adjacent CLB; and
- 4       •forming function generators F, G, H, and J as look up
- 5       tables, thereby allowing all input signals to each look
- 6       up table to be interchangeable.
- 7       •Moreover, except for five-input functions, function
- 8       generators F, G, H, J are also interchangeable.

9       Thus, in accordance with the present invention, the above-  
10      described sparsely pipulated structures 303, 305, 306 and 307  
11      significantly reduces chip area while maximizing flexibility.

12      Signals on output lines Q0-Q3 drive the input lines of  
13      CLBs in neighboring tiles. For example, by placing two core  
14      tiles 101 of Fig. 2A side by side, as in shown in Fig. 2B,  
15      output line Q0 on the left edge of core tile 101b connects to  
16      input line QE0 on the right edge of tile 101a. Other lines  
17      are correspondingly connected. Thus, referring to Figs. 2A,  
18      2B, and 3 in combination, CLB output line X (Fig. 3A) of CLB  
19      301 in CLB matrix 202c (see Fig. 2B) is programmably connected  
20      to output line Q0c, which extends east (as well as other  
21      directions) from CLB matrix 202c in core tile 101c, which in  
22      turn is connected to input line QW0d of CLB matrix 202d in  
23      core tile 101d. PIPs are provided (as discussed above) for  
24      connecting input line QW0 to CLB input lines F0 and FB of CLB  
25      301. Thus, in this manner, a path is established from the  
26      output lines of CLB 301 in CLB matrix 202c to the input lines  
27      of CLB 301 in CLB matrix 202d using only two PIPs, which in  
28      one embodiment includes two transistors.

29      In another embodiment, shown in Fig. 3B, a PIP in CLB  
30      output interconnect structure 304 requires a signal on a CLB  
31      output line to propagate through two transistors (note that  
32      signal K, a constant power or ground signal, propagates  
33      through four transistors). Fig. 3B illustrates a multiplexer  
34      structure 400 which implements all PIPs which connect the  
35      twelve CLB output lines (X, XQ, XB, Y, YQ, YB, Z, ZQ, ZB, V,  
36      VQ, VB) of CLB 301 and one power/ground output signal line K  
37      to output line Q0. Multiplexer structure 400 includes memory

1 cells 31, 32, and 33 which control a first bank of twelve  
2 transistors 351 and select signal K if no transistor in bank  
3 351 is selected. A logic 1 stored in one of memory cells 31,  
4 32, and 33 selects one signal from each group of three signals  
5 in bank 351. If all memory cells 31, 32, and 33 store a logic  
6 0, then signal K is provided to node 30. In a second stage,  
7 memory cells 34 and 35 control AND gates AND1-AND4 to select  
8 the output signal from one of output lines VQ, ZQ, YQ, and XQ  
9 and to provide the selected signal on output line Q0. If  
10 memory cells 31, 32, and 33 store a logic 0, thereby selecting  
11 signal K, then memory cells 34 and 35 must be programmed to  
12 provide the signal at node 30. Thus, thirteen PIPs are  
13 implemented using only 5 memory cells and sixteen transistors,  
14 each path requiring only two transistors for all signals  
15 except the constant value K, which travels a longer path. The  
16 signal on line K is not harmed by having a longer signal path  
17 since it is not a switching signal. A multiplexer structure  
18 400, which selects one of thirteen output signals of CLB 301  
19 to drive a predetermined output line, is provided for each of  
20 output lines Q0-Q7. Note that although it is possible for  
21 none of the thirteen output signals to drive an output line  
22 Q0-Q7, multiplexer structure 400 cannot select more than one  
23 of the thirteen output signals. In this manner, contention on  
24 output lines Q0-Q7 is avoided. In another embodiment of  
25 multiplexer structure 400, thirteen memory cells are provided,  
26 each memory cell controlling a single transistor. In this  
27 manner, each path requires only one transistor, thereby  
28 increasing signal speed. However, note that this embodiment  
29 increases silicon area.  
30

31 Feedback Interconnect Structure 305

32 Referring back to Fig. 3A, feedback interconnect  
33 structure 305 selectively connects output lines Q0-Q3 to CLB  
34 input lines F2, G2, H2, and J2 within configurable logic block  
35 matrix 202. Thus, in this embodiment, any output signal from  
36 CLB 301 can be fed back to selected CLB input lines of any  
37 function generator F, G, H and J in CLB 301. Feedback

1 interconnect structure 305 provides a PIP pattern that  
2 supports a counter (a counter feeds back its own signal) or a  
3 shift register (a shift register requires its neighbor's  
4 signal). The above-described PIP pattern prevents contention  
5 between signals on CLB input lines F2, G2, H2 and J2 and  
6 signals on CLB input lines F0, G0, H0, J0, F1, G1, H1, and J1  
7 which are provided on other input lines to CLB matrix 202,  
8 such as input lines QW0 and QN3. Other embodiments of the  
9 present invention provide different combinations of PIPs in  
10 feedback interconnect structure 305.

11

#### 12 General Input Matrix 306

13 General input matrix 306 receives input signals on tile  
14 interconnect lines M0-M23 and includes PIPs for placing these  
15 input signals onto CLB input lines F0-F3, FB, G0-G3, GB, H0-  
16 H3, HB, J0-J3, and JB. Optionally, a PIP pattern allows a  
17 signal on any tile interconnect line M0-M23 in general input  
18 interconnect structure 306 to drive one input line of each  
19 function generator F, G, H, and J. Because function generator  
20 input signals are interchangeable, (Lookup table inputs are  
21 interchangeable.) no tile interconnect line M0-M23 need be  
22 coupled to more than one input line of a function generator.  
23 In this embodiment of general input interconnect structure  
24 306, PIPs are provided so that each CLB input line FB, GB, HB,  
25 and JB is driven by a signal on one of six tile interconnect  
26 lines M0-M23.

27 As another criterion in this embodiment, no CLB input  
28 line includes more than eight PIPs. Thus, referring to Fig.  
29 3C, a multiplexer structure 401, using only three memory cells  
30 36, 37 and 38, selects one of eight possible signals to  
31 control a first bank of transistors 361. Specifically, memory  
32 cell 38 selects one each of the paired signals on input lines  
33 QW0 or QN0, M15 or M14, M9 or M8, and M7 or M6. Memory cells  
34 36 and 37 provide signals to the input terminals of AND gates  
35 AND5-AND8, which in turn control a second bank of transistors  
36 362 to select a single signal to place on CLB input line F0.

1        In this embodiment of the present invention, the pattern  
2 of PIPs also provides a function of five inputs (discussed  
3 above in connection with Fig. 5C). For example, a signal on  
4 tile interconnect line M18 or M19 drives input line FB, a  
5 signal on tile interconnect line M14 or M15 drives lines F0  
6 and G0, a signal on tile interconnect line M12 or M13 drives  
7 lines F1 and G1, a signal on tile interconnect line M16 or M17  
8 drives input lines F2 and G2 and a signal on tile interconnect  
9 line M20 or M21 drives input lines F3 and G3. In this  
10 configuration, five-input functions are easily implemented  
11 with the PIP pattern provided.

12        In further accordance with the present invention, and  
13 referring to Figs. 3A and 6, PIPs allow connection from long  
14 horizontal lines LH0-LH7 and long vertical lines LV0-LV7, as  
15 well as global (horizontal and vertical) lines GH0, GH1, GV0,  
16 and GV1 to registers RV, RZ, RY, and RX without going through  
17 function generators J, H, G, and F. Specifically, long  
18 horizontal lines LH0-LH7 and long vertical lines LV0 and LV7  
19 as well as global horizontal lines GH0, GH1 and global  
20 vertical lines GV0, GV1 are selectively coupled to tile  
21 interconnect lines M0-M23 (Fig. 6). These tile interconnect  
22 lines, if coupled to CLB input lines FB, GB, HB and JB, bypass  
23 function generators F, G, H and J, respectively, and provide  
24 signals (via intermediate multiplexers) to registers RX, RY,  
25 RZ, RV, respectively (Fig. 3A). Note that global lines GH0,  
26 GH1, GV0, and GV1 are also selectively coupled to registers  
27 RX, RY, RZ and RV via register control interconnect structure  
28 307. Allowing all tile interconnect lines M0-M23 to connect  
29 to one CLB input line FB, GB, HB or JB and providing  
30 connections from every long line to one tile interconnect line  
31 M0-M23 (discussed below in connection with Fig. 6) assures  
32 that signals on those long and global lines can drive the  
33 necessary registers. In the present invention, this PIP  
34 pattern also allows signals on all long lines and global lines  
35 to drive input lines to function generators F, G, H and J via  
36 general input interconnect structure 306.  
37

1    Output Interconnect Matrix 308

2       In this embodiment, output lines Q4-Q7 also provide  
3       output signals to programmable interconnect matrix 201 (Fig.  
4       2A) via tile interconnect lines M0-M11 or via lines TQ4-TQ7.  
5       Output lines Q0-Q3 also provide output signals to selected  
6       ones of tile interconnect lines M12-M23. In the embodiment  
7       shown in Fig. 3A, output interconnect structure 308 allows  
8       signals on each output line Q0-Q7 to drive up to three tile  
9       interconnect lines M0-M23. The full population of CLB output  
10      interconnect structure 304 allows any output line of CLB 301  
11      to be connected to any tile interconnect line M0-M23. Note  
12      that general input interconnect structure 306 also provides  
13      selected feedback signals on output lines Q0-Q3 to CLB 301.

14

15    Register Control Interconnect Structure 307

16       Clock line CLK, clock enable line CE, reset line RST and  
17       tristate line TS may be driven by signals provided on selected  
18       tile interconnect lines M0-M23 (from programmable routing  
19       matrix 201). In addition, for a low skew control, clock line  
20       CLK is driven directly by signals on global horizontal lines  
21       GH0 and GH1 or from global vertical lines GV0 and GV1.

22

23    No Contention

24       In accordance with the present invention, if one PIP on a  
25       predetermined CLB input line is programmed on, then no other  
26       PIP on that CLB input line should be turned on. For example,  
27       if the PIP at the intersection of input line QW0 and CLB input  
28       line F0 is programmed on (i.e. a signal on input line QW0  
29       drives CLB input line F0), then the PIPs on tile interconnect  
30       lines M6, M7, M8, M9, M14, M15, and input line QN0 remain  
31       turned off, thereby ensuring no contention on CLB input line  
32       F0. Typically, contention is avoided either by using a  
33       convenient decode method for selecting which PIP on a single  
34       input line is turned on or by using rules provided in the  
35       software which programs the memory cells to avoid turning on  
36       more than one PIP on an input line. In other embodiments,  
37       alternative input selection means are possible. For example,

1 in one embodiment one memory cell is loaded to specify whether  
2 each PIP is turned on or not.

3

4 Programmable Routing Matrix 201

5 Fig. 6 illustrates the programmable routing matrix 201 of  
6 Fig. 2a. Note that whereas all PIPs in CLB matrix 202 are  
7 shown as triangles to indicate signal flow onto one line, in  
8 Fig. 6, most PIPs in programmable routing matrix 201 are shown  
9 as open circles to indicate signal flow on both lines. The  
10 exceptions are PIPs which connect lines TQ4 through TQ7  
11 (output lines from tristate buffer block 302 of Fig. 3A) to  
12 long horizontal lines LH0-LH7 and long vertical lines LV0-LV7,  
13 and PIPs which place signals from global signal lines GH0,  
14 GH1, GV0, and GV1 onto tile interconnect lines M0 through M3.

15 Extending into programmable routing matrix 201 are global  
16 lines, long lines, double length lines, and single length  
17 lines. Each of these lines is connectable to selected tile  
18 interconnect lines M0-M23. Programmable routing matrix 201  
19 provides connection to programmable routing matrices in  
20 adjacent tiles through single length lines extending in the  
21 four compass directions, i.e. single length north lines N1-  
22 N11, single length east lines E1-E11, single length south  
23 lines S1-S11, and single length west lines W1-W11. Connection  
24 to programmable routing matrices one tile away are provided by  
25 double length north lines DN0 and DN6, double length east  
26 lines DE0 and DE6, double length south lines DS0 and DS6, and  
27 double length west lines DW0 and DW6 (see Fig. 2A). Each long  
28 vertical line LV0-LV7 and long horizontal line LH0-LH7 which  
29 extends through the tile is connectable to one of tile  
30 interconnect lines M0-M23.

31 The particular pattern of PIPs illustrated in Fig. 6 is  
32 sparse, yet provides significant signal transferability.  
33 Specifically, programmable routing matrix 201, which in this  
34 embodiment includes only 124 PIPs, is sparse relative to the  
35 approximately 4200 PIPs which could be provided to connect  
36 every line in Fig. 6 to every other line. However, the PIP  
37 pattern ensures that any line is connectable to any other line

1 if enough intermediate PIPs are used. For example, as shown  
2 in Fig. 6, west line W1 is connectable to east line E1 by  
3 turning on two PIPs which connect tile interconnect line M1 to  
4 these two lines. In contrast, to make a connection between  
5 west line W1 and east line E2 requires 8 PIPs and 9 lines,  
6 i.e. connecting west line W1 to tile interconnect line M1 to  
7 east line E1 to tile interconnect line M20 to west line W9 to  
8 tile interconnect line M9 to north line N9 to tile  
9 interconnect line M21, and finally to east line E2. Although  
10 a path of this length is typically undesirable, in some  
11 applications delay is unimportant. In those applications, the  
12 availability of such a path allows completion of a design.  
13 Easy paths requiring only two PIPs are available to connect  
14 lines N1, S1, E1, and W1 to tile interconnect line M1; lines  
15 N2, S2, E2, and W2 to tile interconnect line M2 and so forth  
16 through tile interconnect line M5. Tile interconnect line M6  
17 connects to double length lines DN6, DS6, DE6, and DW6. Tile  
18 interconnect lines M7 through M11 connect to correspondingly  
19 numbered single length lines extending north, south, east and  
20 west.

21 PIPs on tile interconnect lines M12-M23 implement a  
22 pattern of cross connecting that facilitates signal transfer  
23 flexibility with minimal sacrifice of speed, and the sparse  
24 pipulation achieves valuable reduction of chip area. For  
25 example, tile interconnect line M12 connects to double length  
26 north line DN0, to south line S3, to east line E5, and to west  
27 line W1, whereas tile interconnect line M15 connects to north  
28 line N3, east line E8, double south line DS6, and west line  
29 W4. In this manner, the present invention provides a  
30 predetermined pattern to minimize the number of PIPs, thereby  
31 allowing any line to be connected to any other line. Thus,  
32 the present invention ensures that a path is always provided,  
33 while minimizing silicon area.

34

35 Routing Matrix Model

36 Each of tile interconnect lines M0-M23 is connectable to  
37 five or six other lines. Thus, as shown in Fig. 7A, each tile

1 interconnect line M0-M23 is represented as a star with five or  
2 six points. In this model, eight tile interconnect lines M0  
3 through M7 are programmably connectable to selected ones of  
4 north lines N0-N3, east lines E0-E3, south lines S0-S3 and  
5 west lines W0-W3. Tile interconnect lines M0 through M3 are  
6 connectable to north, south, east and west lines of the same  
7 numerical suffix. Tile interconnect lines M4 through M7 are  
8 connectable to staggered ones of the north, south, east and  
9 west lines. Thus, tile interconnect lines M0-M3 provide a  
10 means for interconnecting north, east, south and west lines of  
11 the same suffix, while tile interconnect lines M4-M7 provide  
12 an opportunity for cross-connecting lines from four compass  
13 directions. Also, tile interconnect lines M0-M7 provide means  
14 for connecting programmable routing matrix 201 to configurable  
15 logic block matrix structure 202 (Fig. 3A).

16

#### 17 Connectivity Model for Routing Matrix and Logic Blocks

18 Fig. 7B illustrates the "star structure" of the present  
19 invention. In a star structure, each CLB 301 is associated  
20 with a particular star 201 (i.e the programmable routing  
21 matrix 201) from which radiate lines connecting to other stars  
22 201 and from there to other CLBs 301. In Fig. 7B, double  
23 length and single length lines are illustrated. In other  
24 embodiments, lines of other lengths are provided in the star  
25 structure. Thus, the star structure of the present invention  
26 ensures good connectivity between its related CLBs and other  
27 parts of the device.

28

#### 29 Global Interconnect Structure

30 Fig. 8 illustrates hard connections from global signal  
31 pads P113, P114, P115, and P116, which are positioned near the  
32 corners of chip 100 (Fig. 1), to global signal lines GTL, GTR,  
33 GBR, and GBL, respectively, which are typically located near  
34 the four edges of chip 100. Each global signal line is  
35 programmably connectable to a plurality of lines extending  
36 vertically or horizontally through each row or column of core  
37 tiles 101. For example, top left global signal line GTL is

1 connectable to global vertical lines GV1-a through GV1-n, via  
2 PIPs PV1-a through PV1-n, respectively, i.e. one PIP for each  
3 column of core tiles 101. Top right global signal line GTR is  
4 connectable via PIPs PH0-a through PH0-m, respectively, i.e.  
5 one PIP for each row of core tiles 101 to global horizontal  
6 lines GH0-a. Bottom right global signal line GBR is  
7 connectable to global vertical lines GV0-a through GV0-n.  
8 Finally, bottom left global signal line GBL is connectable to  
9 global horizontal lines GH1-a through GH1-m. Note that the  
10 global vertical and horizontal lines with reference labels  
11 beginning with GV or GH are connectable to programmable  
12 routing matrices 201 and CLB matrices 202 in core tiles 101  
13 through which the global lines pass, as discussed above in  
14 connection with Figs. 2A, 3, and 7.

15 As also shown in Fig. 8, long lines LV0L, LV7L, LH0T,  
16 LH7T, LV0R, LV7R, LH0B, and LH7B which extend through the edge  
17 tiles (not shown in Fig. 8 for simplicity but shown in Figs.  
18 10A through 10D) of chip 100 (Fig. 1) are also connectable to  
19 the global lines. Specifically, bottom right global signal  
20 line GBR can be driven by signals on bottom horizontal long  
21 lines LH0B and LH7B via PIPs PGBR0 and PGBR7, respectively.  
22 Bottom left global signal line GBL can be driven by signals on  
23 left vertical long lines LV0L and LV7L via bottom left buffer  
24 BBL via PIPs PGBL0 and PGBL7, respectively. Equivalent  
25 connections are provided for the top and right edges of the  
26 chip. Left, top, right, and bottom long lines are connectable  
27 to each other through PIPs, such as PIP PBR7. Because long  
28 lines LV0L, LV7L, etc. are driven by signals provided by any  
29 of the pads at the perimeter of the chip (through edge tiles  
30 103-106 discussed below in connection with Figs. 10A-10D), any  
31 pad can provide a global signal. Moreover, any of core tiles  
32 101 can also provide a global signal through edge tiles 103-  
33 106.

34

35 Optional Long Line Splitter

36 Figs. 1 and 9 illustrate one embodiment of the present  
37 invention which includes long line splitters LLS which may be

1 positioned partly through a line. Two columns of tiles are  
2 illustrated in Fig. 9, each column comprising a top edge tile  
3 104, six core tiles 101, and a bottom edge tile 106. Long  
4 vertical lines LV0-LV7 traverse all core tiles 101, and in  
5 each of the two columns terminate in edge tiles 104 and 106.  
6 Long vertical lines LV0-LV7 are also connectable to selected  
7 ones of tile interconnect lines M0-M15 and lines TQ0-TQ3 in  
8 edge tiles 104 and 106, as will be discussed below in  
9 connection with Figs. 10A-10D. Furthermore, as discussed  
10 above in connection with Figs. 2A and 6, long lines LV0-LV7  
11 are connectable to selected lines in programmable routing  
12 matrices 201. For clarity, horizontal long lines LH0-LH7 are  
13 not illustrated in Fig. 9, but are illustrated in Figs. 2A and  
14 6.

15 In the embodiment shown in Fig. 9, vertical long lines  
16 LV0-LV7 in the three upper core tiles 101 are separated from  
17 the portions in the three lower core tiles 101 by long line  
18 splitters LLS. An inset illustrates that a long splitter LLS  
19 in one embodiment comprises an n-type transistor which is  
20 turned off by providing a low voltage to a control gate CG,  
21 thereby separating the vertical long line into top and bottom  
22 segments. Long line splitters LLS are typically used in large  
23 chip embodiments to allow top and bottom long lines to be  
24 separately driven in different portions of the chip. As shown  
25 in Fig. 1, horizontal long lines LH0-LH7 are also separated in  
26 the middle of chip 100 by long line splitters LLS. In other  
27 embodiments, several long line splitters such as long line  
28 splitters LLS and LLSA are provided along the same long line,  
29 or long line splitters LLSB are provided between an end of a  
30 long lines in one edge tile and an end of a long line in an  
31 adjacent edge tile, thereby programmably connecting these long  
32 lines.

33

34 Edge Tiles for Embodiment of Fig. 2A

35 Figs. 10A-10D illustrate in greater detail the edge tiles  
36 shown in Fig. 2A. Specifically, Figs. 10A-10D show left edge  
37 tile 103, top edge tile 104, right edge tile 105, and bottom

1 edge tile 106, respectively. Each edge tile in these  
2 embodiments is typically but not always connected to at least  
3 one of pads PV, PZ, PY or PX. In other embodiments described  
4 in detail below in reference to Fig. 1, at least one edge tile  
5 is not connected to any pad.

6 In Fig. 10A, four pads, PV, PZ, PY, and PX are connected  
7 to edge tile 103 via input/output (I/O) devices IOBV, IOBZ,  
8 IOBY and IOBX, respectively. Each of I/O devices IOBV, IOBZ,  
9 IOBY and IOBX is connected to edge tile 103 by three lines.  
10 For example, I/O device IOBV is connected to edge tile 106 by  
11 an I/O input line IV, an I/O output line OV, and a tri-state  
12 line TSV. Note that the output signal provided to pad P42 by  
13 output line OV is controlled by a signal on I/O tri-state line  
14 TSV. Similar lines are provided for I/O devices IOBZ, IOBY  
15 and IOBX.

16 A fully pipulated I/O input interconnect structure 1001  
17 allows signals on I/O input lines IV, IZ, IY, and IX to drive  
18 edge tile input lines QIN0-QIN3. Neighbor output interconnect  
19 structure 1004 allows signals on output lines QE0-QE3 from a  
20 core tile 101 to be provided to pads PV, PZ, PY and PX. I/O  
21 output interconnect structure 1002 allows signals from the  
22 neighboring core tiles (in edge tile 103, provided by north  
23 lines 100-N7, south lines S0-S7, and east lines E1-E5 and E7-  
24 E11) as well as signals on long lines LH0-LH7 and LV0-LV7 and  
25 double length lines DH0, DH6, to be provided to the pads.  
26 Note that I/O output interconnect structure 1002 has a  
27 substantially complete pipulation, thereby allowing any signal  
28 coming into left edge tile 103 from elsewhere in the chip  
29 interior to be placed on any of pads PV, PX, PY or PZ in spite  
30 of a sparse general interconnect structure 1006 between lines  
31 coming from other parts of the chip interior into or out of  
32 left edge tile 103 and a set of edge tile interconnect lines  
33 M0-M15.

34 Intermediate interconnect structure 1003 allows signals  
35 which come from one of tile interconnect lines M0-M15 to be  
36 placed on one of edge tile input lines QIN0-QIN3, buffered  
37 onto a corresponding output line Q0 through Q3, and provided

1 through tristate buffer block 302 to a corresponding line TQ0-  
2 TQ3. A signal can thence be provided to horizontal long lines  
3 LH0-LH7 and vertical long lines LV0-LV7. Thus, signals on  
4 edge tile input lines QIN0-QIN3 drive output lines Q0-Q3  
5 directly and drive lines TQ0-TQ3 through tri-state buffer  
6 block 302.

7 Feedback interconnect structure 1005 allows signals on  
8 output lines Q0-Q3 to drive tile interconnect lines M0-M15  
9 which are in turn selectively connected to north lines N0-N7,  
10 south lines S0-S7, east lines E1-E11, double length lines DE0,  
11 DE6, DH0, and DH6 and to long lines LV0-LV7. In this manner  
12 edge tile 103 allows connection to pads which in turn have  
13 external connections to chip 100, as well as on an adjacent  
14 core tile 101 chip and to adjacent edge tiles (or an adjacent  
15 corner tile, explained in detail below). Pads PV, PZ, PY, and  
16 PX represent pads P42, 41, 40 and P39, respectively, which are  
17 shown in Fig. 1.

18 Figs. 10B, 10C, and 10D show embodiments of edge tiles  
19 104, 105, and 106, respectively. Because these tiles are  
20 similar in structure, except for orientation, and have  
21 identical numerical references to that shown in Fig. 10A, the  
22 detail of the interface structures in Figs. 10B, 10C, and 10D  
23 will not be discussed herein.  
24

#### 25 I/O Interface for Use With Optional Pad

26 Fig. 10C illustrates a combination of connected and  
27 unconnected pads, thereby illustrating the flexibility  
28 available at the mask level.

29 In this embodiment, one unconnected pad PZ and connected  
30 pads PV, PY, PX implement a configuration which is represented  
31 in Fig. 1 by pads P6, P7 and P8 (connected to edge tile 105).  
32 As shown in Fig. 1, each edge tile has a predetermined number  
33 of pads connected to it. For example, pad P17 is the only pad  
34 connected to its edge tile 106. Therefore, as shown in Fig.  
35 10D, only one of pads PV, PZ, PY and PX (in this embodiment,  
36 pad PV) is connected to edge tile 106.

1 Referring back to Fig. 10C, pad PZ and its input/output  
2 buffer structure IOBZ are eliminated, thereby reducing total  
3 chip size by reducing the total number of pads on the chip.  
4 Input line IZ and output line OZ are shorted together in a  
5 region which in one embodiment is outside tile 105. In this  
6 manner, all tiles 105 are identically laid out, regardless of  
7 how many pads PV, PZ, PY, or PX are provided. Referring back  
8 to Fig. 1, pads P6, P7 and P8 are connected to a single edge  
9 tile 105. In Fig. 10D, pad PY and related structures IOBY and  
10 ESDY are not provided. Thus, the embodiment of Fig. 10D  
11 represents pads P26 through P28 of Fig. 1. In other  
12 embodiments of the present invention, other pads are removed,  
13 up to and including removal of all four pads. For example,  
14 Fig. 1 includes certain edge tiles to which no pads have been  
15 connected (two of edge tiles 103, one of edge tiles 104, and  
16 one of edge tiles 105 have no pads at all connected to them).  
17

#### 18 Corner Tiles

19 Figs. 11A through 11D illustrate the four corner tiles  
20 113, 114, 115, and 116, respectively, of chip 100 (Fig. 1).  
21 Fig. 11A includes a conventional boundary scan block BSCAN  
22 compatible with IEEE 1149.1 described in detail in a Xilinx  
23 Application Note by Luis Morales entitled, "Boundary Scan in  
24 XC4000 Devices" and available from Xilinx, Inc., 2100 Logic  
25 Drive, San Jose, CA 95124, which is herein incorporated by  
26 reference in its entirety. In Fig. 11A, top left corner tile  
27 113 includes hard connections from single length east lines  
28 E0-E7 to single length south lines S0-S7, respectively, and  
29 programmable connections from long horizontal lines LH0-LH7 to  
30 long vertical lines LV0-LV7, respectively. Fig. 11A further  
31 shows one embodiment of an interconnect structure 1101 which  
32 provides the programmable connection of boundary scan block  
33 BSCAN to the above-described single length and long lines.  
34 Corner tile 113 also includes a programmable connection to an  
35 external pin P43 that provides a global clock signal SGCK1.

36 Corner tile 114, illustrated in Fig. 11B, is similar in  
37 configuration to corner tile 113 (Fig. 11A). Specifically,

1 tile 114 (Fig. 11B) includes hard connections for connecting  
2 single length west lines W0-W7 to single length south lines  
3 S0-S7, respectively, and programmable connections for  
4 connecting long horizontal lines LH0-LH7 to long vertical  
5 lines LV0-LV7, respectively. In both Figs. 11A and 11B, long  
6 vertical line LV0 connects to long horizontal line LH0, but  
7 because of the layout of tiles 113 and 114, the lines are  
8 drawn in a different position on the page, and therefore  
9 corner tiles 113 and 114 have a different appearance in Figs.  
10 11A and 11B. Corner tile 114 includes a clock input pin P1  
11 that provides clock signal SGCK4. Corner tile 114 includes an  
12 interconnect structure 1102 which provides a programmable  
13 connection between a conventional oscillator/counter circuit  
14 DIV used for counting bits during configuration of chip 100  
15 and the above-described single length and long lines. In one  
16 embodiment, circuit DIV is used during chip operation to  
17 provide an on-chip oscillator or a counter-divider. Circuit  
18 DIV is typically configured to divide an internal oscillator  
19 signal or a user-provided signal. Corner tile 114 further  
20 includes a boundary scan update signal BSUPD, which is part of  
21 the standard boundary scan circuitry (most of the circuitry  
22 being located in tile 113). In this embodiment, signal BSUPD  
23 is programmably placed on west lines W2 and W3 (and thus south  
24 lines S2 and S3) as well as long horizontal lines LH2 and LH3  
25 (and thus long vertical lines LV2 and LV3).

26 Fig. 12 illustrates one embodiment of a circuit which  
27 implements oscillator/counter circuit DIV of Fig. 11B. Two  
28 output taps, OSC1 and OSC2 are provided, which together can be  
29 configured to provide twelve frequencies which are divisions  
30 of the original input frequency. An internal oscillator OSC  
31 provides an oscillator signal to NAND gate 1231. NAND gate  
32 1231 is enabled by a memory cell OSRUN. When enabled, the  
33 output signal from oscillator OSC is provided to multiplexer  
34 1201.

35 Memory cell 1202 determines whether multiplexer 1201  
36 provides the output signal from internal oscillator OSC or a  
37 signal on one of single length west lines W0-W3 (equal to a

1 signal on single length south lines S0-S3, respectively, see  
2 Fig. 11B), or a signal on one of long horizontal lines LH0-LH3  
3 (equal to a signal on long vertical lines LV0-LV3).  
4 Multiplexer 1201 provides an output signal which is then  
5 available to be divided by flip flops 1214 through 1220.

6 Multiplexers 1225 and 1226 provide a choice of divide  
7 factors on the data input terminals of flip flops 1227 and  
8 1228 respectively. The outputs of these flip flops are  
9 provided as signals on taps OSC1 and OSC2. Flip flops 1227  
10 and 1228 are clocked from the original input signal and serve  
11 to reduce the skew of the output signals from multiplexers  
12 1225 and 1226. Multiplexer 1225, under control of memory  
13 cells OSC1A and OSC1B, provides a switching signal which can  
14 be the input signal from multiplexer 1201 divided by 4, 16,  
15 64, or 256. Depending upon the setting in memory cell 1203,  
16 multiplexer 1204 can forward the original clock signal output  
17 from multiplexer 1201 or can provide a divided signal (the  
18 original frequency divided by 512) which is output from flip  
19 flop 1213. If multiplexer 1204 is set to provide the output  
20 signal of multiplexer 1201, then the original clock signal is  
21 alternatively provided by multiplexer 1226 as divided by 2, 8,  
22 32, or 128. If multiplexer 1204 is set to provide a divided  
23 signal from flip flop 1213, multiplexer 1226 will provide an  
24 output signal which has the frequency of the original input  
25 signal on multiplexer 1201 divided by 1024, 4096, 16,384, or  
26 65,536. Thus, the signals on output taps OSC1 and OSC2 are  
27 programmed to oscillate at many different choices of  
28 frequency.

29 Fig. 11C shows lower right corner tile 115. Corner tile  
30 115 programmably connects long horizontal lines LH0-LH7 and  
31 long vertical lines LV0-LV7, respectively, and connects north  
32 lines N0-N7 to west lines W0-W7. Corner tile 115 further  
33 includes a programmable interconnect structure 1103 which  
34 programmably connects a start-up block STARTUP to north lines  
35 N0-N7 (and thus west lines W0-W7) and long vertical lines LV0-  
36 LV7 (and thus long horizontal lines LH0-LH7). Start-up block  
37 STARTUP includes circuitry to sequence the signals and control

1 timing of the start-up function as chip 100 (Fig. 1) is  
2 activated.

3 During the start-up function, three events are necessary  
4 to move from configuration mode to operating mode: release of  
5 the signal on a global tri-state signal terminal GTS, release  
6 of the signal on a global reset signal terminal GSR, and  
7 release of a signal on a load complete terminal DONE  
8 (indicating that all configuration bits have been loaded into  
9 their appropriate locations in the FPGA). The start-up block  
10 STARTUP allows the user to program the order in which these  
11 signals are released, as well as the timing of these signals  
12 (for example separating each signal from another signal by  
13 one, two, or three clock cycles).

14 Fig. 11D shows lower left tile 116 with single length and  
15 long lines connected similarly to the other three corner  
16 tiles. In addition, lower left corner tile 116 includes a  
17 read-back unit RDBK. Read-back unit RDBK allows the user to  
18 read the content of the configuration memory onto any data  
19 line and out onto any external pin through the data line  
20 terminal DATA of readback unit RDBK. The trigger terminal  
21 TRIG in read-back unit RDBK carries a signal that triggers  
22 copying of one row of configuration data from the  
23 configuration memory into the same shift register which loaded  
24 the configuration memory. The signal on a clock terminal CLK  
25 controls shifting out of that data onto line DATA. The signal  
26 on a read-in-progress terminal RIP prevents the chip from  
27 sending another signal from trigger terminal TRIG while data  
28 are still being shifted out. With this circuit, depending on  
29 the original configuration paths to corner tile 116, the  
30 configuration data for the entire chip is shifted out of the  
31 chip onto almost any one of the external pins while the chip  
32 is operating.

33 In light of the above description, many other embodiments  
34 of the present invention will be apparent to those skilled in  
35 the art. For example, although the above description relates  
36 to an embodiment in which core tiles are rectangular or

1 square, another embodiment of the present invention includes  
2 tiles having six sides.

3 As mentioned above, core tiles need not be identical. A  
4 set of tile designs may be provided which have different logic  
5 content from each other. If all tile designs follow common  
6 boundary constraints, chips can be formed by combining the  
7 tile designs in a variety of patterns. To be successful, each  
8 tile design must have a good distribution of signals within  
9 the tile. The routing matrix of the tile must efficiently  
10 distribute the incoming signals to the logic block input  
11 terminals and take the logic block output signals to the tile  
12 edges. Indeed a chip may be composed in which some tiles  
13 include RAM memory and no logic, or a combination of tiles  
14 having logic, tiles having memory only, and tiles having  
15 routing with no logic or memory. Further, a tile may be  
16 designed which includes an input/output pad physically within  
17 its structure, and tile designs including a pad may be  
18 combined with other tile designs to achieve distributed access  
19 to logic. Such other embodiments are intended to fall within  
20 the scope of the present invention. The present invention is  
21 set forth in the claims.

1    CLAIMS

2        1. An FPGA tile architecture having a plurality of core  
3        tiles, each core tile comprising:  
4              a configurable logic block matrix;  
5              a programmable routing matrix;  
6              connection means for connecting said configurable logic  
7              block to other configurable logic block matrices in  
8              adajacent core tiles;  
9              inter-matrix lines for connecting said configurable logic  
10          block to said programmable routing matrix; and  
11          routing lines for connecting said programmable routing  
12          matrix to programmable routing matrices in adjacent  
13          core tiles.

14

15        2. The FPGA tile architecture of Claim 1 wherein said  
16        core tiles are identical.

17

18        3. The FPGA tile architecture of Claim 1 wherein one  
19        core tile is different from another core tile.

20

21        4. The FPGA tile architecture of Claim 1 in which said  
22        adjacent core tiles are positioned north, south, east, and  
23        west of said core tile.

24

25        5. The FPGA tile architecture of Claim 1 further  
26        including a plurality of long lines extending horizontally  
27        through said core tile, wherein at least one of said plurality  
28        of long lines is coupled to at least one of said inter-matrix  
29        lines.

30

31        6. The FPGA tile architecture of Claim 5 further  
32        including a plurality of long lines extending vertically  
33        through said core tile, wherein at least one of said plurality  
34        of long lines is coupled to at least one of said inter-matrix  
35        lines.

36

1        7. The FPGA tile architecture of Claim 6 further  
2 including a global horizontal line coupled to said  
3 configurable logic block matrix and said programmable routing  
4 matrix.

5

6        8. The FPGA tile architecture of Claim 7 further  
7 including a global vertical line coupled to said configurable  
8 logic block matrix and said programmable routing matrix.

9

10       9. The FPGA tile architecture of Claim 8 further  
11 including a multiple length line, wherein said multiple length  
12 line couples programmable routing matrices that are not in  
13 adjacent core tiles.

14

15       10. The FPGA tile architecture of Claim 9 wherein said  
16 multiple length line is a double length line.

17

18       11. The FPGA tile architecture of Claim 1 wherein said  
19 connection means includes a carry-out line and a carry-in  
20 line, wherein said carry-out line is coupled to a carry-in  
21 line in an adjacent core tile.

22

23       12. The FPGA tile architecture of Claim 11 wherein said  
24 carry-in line is coupled to a carry-out line in an adjacent  
25 core tile.

26

27       13. The FPGA tile architecture of Claim 9 wherein said  
28 connection means includes:

29              a plurality of input lines to said configurable logic  
30              block matrix;  
31              a plurality of output lines from said configurable logic  
32              block matrix, wherein at least one of said plurality  
33              of input lines is coupled to one of said plurality  
34              of output lines in an adjacent core tile, and at  
35              least one of said plurality of output lines is  
36              coupled to one of said plurality of input lines in  
37              an adjacent core tile.

1

2        14. The FPGA tile architecture of Claim 13 wherein said  
3        configurable logic block matrix comprises:

4              a plurality of logic block input lines programmably  
5              connected to said plurality of input lines through  
6              an input interconnect structure; and  
7              a plurality of logic block output lines programmably  
8              connected to said plurality of output lines through  
9              an output interconnect structure.

10

11        15. The FPGA tile architecture of Claim 14 wherein said  
12        configurable logic block matrix further includes a  
13        configurable logic block coupled between said plurality of  
14        logic block input lines and said plurality of logic block  
15        output lines.

16

17        16. The FPGA tile architecture of Claim 15 wherein said  
18        output interconnect structure is more fully pipulated than  
19        said input interconnect structure.

20

21        17. The FPGA tile architecture of Claim 16 wherein said  
22        input interconnect structure is sparsely pipulated.

23

24        18. The FPGA tile architecture of Claim 17 wherein said  
25        output interconnect structure is fully pipulated.

26

27        19. The FPGA tile architecture of Claim 15 wherein said  
28        configurable logic block matrix further includes a feedback  
29        interconnect structure for programmably connecting said output  
30        lines to said logic block input lines.

31

32        20. The FPGA tile architecture of Claim 19 wherein said  
33        configurable logic block matrix further includes a general  
34        interconnect structure for programmably connecting said inter-  
35        matrix lines to said logic block input lines.

36

1        21. The FPGA tile architecture of Claim 20 wherein at  
2 least one of said inter-matrix lines includes a buffer.

3

4        22. The FPGA tile architecture of Claim 20 wherein said  
5 configurable logic block includes a plurality of function  
6 generators, each function generator coupled to a subset of  
7 said logic block input lines.

8

9        23. The FPGA tile architecture of Claim 22 wherein said  
10 configurable logic block further includes a plurality of  
11 multiplexers, wherein at least one of said plurality of  
12 function generators provides a signal to at least one of said  
13 plurality of multiplexers.

14

15        24. The FPGA tile architecture of Claim 23 wherein said  
16 configurable logic block further includes a plurality of  
17 register means, and wherein at least one of said plurality of  
18 multiplexers provides a signal to at least one of said  
19 plurality of registers.

20

21        25. The FPGA tile architecture of Claim 24 wherein at  
22 least one function generator is coupled to one logic block  
23 output line.

24

25        26. The FPGA tile architecture of Claim 25 wherein at  
26 least one multiplexer is coupled to one logic block output  
27 line.

28

29        27. The FPGA tile architecture of Claim 26 wherein at  
30 least one register is coupled to one logic block output line.

31

32        28. The FPGA tile architecture of Claim 27 wherein at  
33 least one multiplexer is coupled to said carry-out line.

34

35        29. The FPGA tile architecture of Claim 28 wherein at  
36 least one multiplexer is coupled to said carry-in line.

37

1       30. The FPGA tile architecture of Claim 22 wherein said  
2 configurable logic block further includes groups of  
3 multiplexers, each group of multiplexers coupled to one of  
4 said plurality of function generators.

5

6       31. The FPGA tile architecture of Claim 30 wherein said  
7 configurable logic block further includes a plurality of  
8 register means, and wherein each group of multiplexers  
9 provides a signal to one of said plurality of register means.

10

11       32. The FPGA tile architecture of Claim 31 wherein each  
12 function generator is coupled to one logic block output line.

13

14       33. The FPGA tile architecture of Claim 32 wherein at  
15 least one multiplexer of each group of multiplexers is coupled  
16 to one logic block output line.

17

18       34. The FPGA tile architecture of Claim 33 wherein each  
19 register is coupled to one logic block output line.

20

21       35. The FPGA tile architecture of Claim 34 wherein at  
22 least one multiplexer is coupled to a carry-out line of said  
23 configurable logic block.

24

25       36. The FPGA tile architecture of Claim 35 wherein at  
26 least one multiplexer is coupled to a carry-in line of said  
27 configurable logic block.

28

29       37. The FPGA tile architecture of Claim 20 wherein said  
30 output interconnect structure includes a first plurality of  
31 transistors, each transistor provided on one logic block  
32 output line.

33

34       38. The FPGA tile architecture of Claim 35 wherein said  
35 output interconnect structure includes a first plurality of  
36 memory devices, each memory device controlling the state of a  
37 subset of said plurality of transistors.

1       39. The FPGA tile architecture of Claim 38 wherein said  
2 output interconnect structure includes a second plurality of  
3 transistors, each of said second plurality of transistors  
4 coupled between a subset of said plurality of logic block  
5 output lines and one output line.

6

7       40. The FPGA tile architecture of Claim 39 wherein said  
8 output interconnect structure further includes a second  
9 plurality of memory devices that control the state of said  
10 second plurality of transistors.

11

12       41. The FPGA tile architecture of Claim 20 wherein said  
13 input interconnect structure and said general interconnect  
14 structure include a first plurality of transistors, said first  
15 plurality of transistors provided on a subset of said  
16 plurality of inter-matrix lines and on a subset of said  
17 plurality of input lines.

18

19       42. The FPGA tile architecture of Claim 41 wherein said  
20 input interconnect structure and said general interconnect  
21 structure include at least one memory device that controls the  
22 state of said first plurality of transistors.

23

24       43. The FPGA tile architecture of Claim 41 wherein said  
25 input interconnect structure and said general interconnect  
26 structure include a second plurality of transistors, each of  
27 said second plurality of transistors coupled between either a  
28 further subset of said plurality of inter-matrix lines or a  
29 further subset of said plurality of input lines and one logic  
30 block input line.

31

32       44. The FPGA tile architecture of Claim 43 wherein said  
33 input interconnect structure and said general interconnect  
34 structure further includes a second plurality of memory  
35 devices that control the state of said second plurality of  
36 transistors.

37

1        45. The FPGA tile architecture of Claim 20 wherein said  
2 programmable routing matrix includes a programmable  
3 interconnect structure for coupling said routing lines to said  
4 inter-matrix lines.

5

6        46. The FPGA tile architecture of Claim 45 wherein said  
7 programmable interconnect structure further couples said  
8 plurality of long lines extending horizontally through said  
9 core tile to said inter-matrix lines.

10

11        47. The FPGA tile architecture of Claim 46 wherein said  
12 programmable interconnect structure further couples said  
13 plurality of long lines extending vertically through said core  
14 tile to said inter-matrix lines.

15

16        48. The FPGA tile architecture of Claim 47 wherein said  
17 programmable interconnect structure further couples said  
18 multiple length line to said inter-matrix lines.

19

20        49. The FPGA tile architecture of Claim 48 wherein said  
21 programmable interconnect structure further couples said  
22 global horizontal line to an inter-matrix line.

23

24        50. The FPGA tile architecture of Claim 49 wherein said  
25 programmable interconnect structure further couples said  
26 global vertical line to an inter-matrix line.

27

28        51. The FPGA tile architecture of Claim 6 wherein at  
29 least one of said long lines, either extending horizontally or  
30 vertically across said core tile, includes a long line  
31 splitter, wherein said long line splitter includes means for  
32 preventing conduction of said at least one long line.

33

34        52. The FPGA tile architecture of Claim 51 wherein said  
35 means for preventing conduction includes a transistor.

36

1        53. The FPGA tile architecture of Claim 52 wherein said  
2 transistor is an n-type transistor.

3

4        54. The FPGA tile architecture of Claim 20 further  
5 including a plurality of edge tiles, wherein each edge tile is  
6 coupled to at least one other edge tile and one core tile.

7

8        55. The FPGA tile architecture of Claim 54 wherein each  
9 edge tile is further coupled to an input/output (I/O) device.

10

11        56. The FPGA tile architecture of Claim 55 wherein said  
12 I/O device is coupled to a pad which provides an external  
13 connection to said chip.

14

15        57. The FPGA tile architecture of Claim 56 wherein an  
16 electrostatic discharge device connects to said pad.

17

18        58. The FPGA tile architecture of Claim 56 wherein said  
19 edge tile includes means for coupling said I/O device to said  
20 routing lines, said input lines, said output lines, and said  
21 multiple length line.

22

23        59. The FPGA tile architecture of Claim 58 wherein said  
24 means for coupling couples either said global horizontal line  
25 or said global vertical line to said I/O device.

26

27        60. The FPGA tile architecture of Claim 56 wherein said  
28 means for coupling includes a first interconnect structure.

29

30        61. The FPGA tile architecture of Claim 54 further  
31 including a plurality of corner tiles, wherein each corner  
32 tile is connected to two adjacent edge tiles.

33

34        62. The FPGA tile architecture of Claim 61 wherein said  
35 corner tile connects said plurality of long lines extending  
36 horizontally across said core tile to said plurality of long  
37 lines extending vertically across said core tile.

1       63. The FPGA tile architecture of Claim 61 wherein said  
2 corner tiles further connect a first subset of said plurality  
3 of routing lines to a second subset of said plurality of  
4 routing lines.

5

6       64. The FPGA tile architecture of Claim 61 wherein said  
7 corner tile includes a corner tile interconnect structure for  
8 programmably connecting said plurality of long lines extending  
9 horizontally across said core tile and said first subset of  
10 said plurality of routing lines to a selected circuit.

11

12       65. The FPGA tile architecture of Claim 64 wherein said  
13 selected circuit is a boundary scan block.

14

15       66. The FPGA tile architecture of Claim 64 wherein said  
16 selected circuit is an oscillator/counter circuit.

17

18       67. The FPGA tile architecture of Claim 64 wherein said  
19 selected circuit is a start-up block.

20

21       68. The FPGA tile architecture of Claim 64 wherein said  
22 selected circuit is a read-back unit.

23

24       69. The FPGA tile architecture of Claim 61 wherein said  
25 edge tiles further includes means for programmably connecting  
26 an external pin to at least one of said long lines extending  
27 horizontally across said core tile.

28

29       70. An FPGA tile architecture comprising:  
30           a plurality of paired structures, each paired structure  
31           including a configurable logic block matrix and a  
32           programmable routing matrix;  
33           a plurality of lines for connecting said configurable  
34           logic block matrix to said programmable routing  
35           matrix; and

1       means for connecting said programmable routing matrix to  
2           other programmable routing matrices in other paired  
3           structures.

4

5       71. The FPGA tile architecture of Claim 70 further  
6           comprising means for connecting said configurable logic block  
7           matrix in one paired structure to a plurality of configurable  
8           logic block matrices in other paired structures without using  
9           said programmable routing matrix.

10

11       72. The FPGA tile architecture of Claim 70 wherein said  
12           means for connecting comprises:

13           a plurality of single length lines which connect a first  
14           programmable routing matrix to adjacent programmable  
15           routing matrices;

16           a plurality of double length lines which connect said  
17           first programmable routing matrix to non-adjacent  
18           programmable routing matrices.

19

20       73. The FPGA tile architecture of Claim 70 further  
21           comprising:

22           a plurality of long lines, each long line being  
23           programmably connectable to a plurality of adjacent  
24           programmable routing matrices.

25

26       74. An interconnect structure comprising:  
27           a plurality of signal lines;  
28           a first plurality of transistors, each transistor  
29           provided on one signal line;  
30           at least one memory device for controlling the state of  
31           said plurality of transistors;  
32           a second plurality of transistors, each transistor  
33           coupled to a subset of said first plurality of  
34           transistors; and  
35           means for controlling the states of said second plurality  
36           of transistors, wherein said means for controlling

1        determines which of said second plurality of transistors  
2        provides a signal on an output line.

3

4        75. The interconnect structure of Claim 74 further  
5        comprising a third plurality of transistors coupled in series  
6        to one subset of said first plurality transistors.

7

8        76. The interconnect structure of Claim 75 wherein said  
9        at least one memory device includes a plurality of memory  
10      devices, and wherein each memory device controls the state of  
11      one of said third plurality of transistors.

12

13        77. The interconnect structure of Claim 76 wherein said  
14      plurality of memory devices provide a signal to said first  
15      plurality of transistors and the complement of said signal to  
16      said third plurality of transistors.

17

18        78. An interconnect structure comprising:  
19            a plurality of lines;  
20            a first plurality of transistors, each transistor  
21            provided on one signal line;  
22            a first memory device for controlling the state of said  
23            first plurality of transistors, wherein said means  
24            for controlling provides a signal to a first group  
25            of said first plurality of transistors and provides  
26            the complement of said signal to a second group of  
27            said first plurality of transistors;  
28            a second plurality of transistors, each transistor  
29            coupled to a subset of said first plurality of  
30            transistors;  
31            a second memory device for controlling the state of said  
32            second plurality of transistors, wherein said means  
33            for controlling provides a signal to a first group  
34            of said second plurality of transistors and provides  
35            the complement of said signal to a second group of  
36            said second plurality of transistors;

1        a third plurality transistors, each transistor coupled to  
2        a subset of said second plurality of transistors;  
3        a third memory device for controlling the state of said  
4                third plurality of transistors, wherein said means  
5                for controlling provides a signal to a first group  
6                of said third plurality of transistors and provides  
7                the complement of said signal to a second group of  
8                said third plurality of transistors, wherein one of  
9                said third plurality of transistors provides a  
10              signal on an output line.

11

12        79. A tile based FPGA architecture including:  
13                a plurality of core tiles formed in rows and columns,  
14                wherein each core tile includes a configurable logic  
15                block matrix and an associated programmable routing  
16                matrix;  
17                a plurality of edge tiles formed on the north, east,  
18                south, and west perimeters of said plurality of core  
19                tiles; and  
20                a plurality of corner tiles formed adjacent said  
21                plurality of edge tiles.

22

23        80. The tile based FPGA architecture of Claim 79 further  
24                including a plurality of horizontal long lines extending  
25                through each row of said core tiles and said edge tiles formed  
26                on the north and south perimeters.

27

28        81. The tile based FPGA architecture of Claim 80 further  
29                including a plurality of vertical long lines extending through  
30                each column of said core tiles and said edge tiles formed on  
31                the east and west perimeters.

32

33        82. The tile based FPGA architecture of Claim 81 wherein  
34                the horizontal long lines extending through said edge tiles  
35                formed on the north and south perimeters are coupled to said  
36                vertical long lines extending through said edge tiles formed

1 on the east and west perimeters by said plurality of corner  
2 tiles.

3

4 83. The tile based FPGA architecture of Claim 82 wherein  
5 each core, edge, or corner tile includes at least two lines;  
6 wherein one corner tile includes a north line coupled to an  
7 east line, another corner tile includes a south line coupled  
8 to an east line, another corner tile includes a west line  
9 coupled to a south line, and another corner tile includes a  
10 north line coupled to a west line; wherein one edge tile on  
11 said south perimeter includes a north line coupled to an east  
12 line and a west line, another edge tile on said west perimeter  
13 includes an east line coupled to a north line and a south  
14 line, another edge tile on said north perimeter includes a  
15 south line coupled to an east line and a west line, and  
16 another edge tile on said east perimeter includes an east line  
17 coupled to a north line and a south line; wherein a core tile  
18 includes a north line coupled to an east line, a south line,  
19 and a west line, wherein the west line of a corner tile is  
20 coupled to the east line of an edge tile formed on said north  
21 perimeter or said south perimeter, wherein the east line of a  
22 corner tile is coupled to the west line of an edge tile formed  
23 on said north perimeter or said south perimeter, wherein the  
24 south line of a corner tile is coupled to the north line of an  
25 edge tile formed on said east perimeter or said west  
26 perimeter, wherein the north line of a corner tile is coupled  
27 to the south line of an edge tile formed on said east  
28 perimeter or said west perimeter; wherein the south line of an  
29 edge tile formed on said north perimeter is coupled to the  
30 north line of a core tile, wherein the west line of an edge  
31 tile formed on said east perimeter is coupled to the east  
32 line of a core tile, wherein the north line of an edge tile  
33 formed on said south perimeter is coupled to the south line of  
34 a core tile, and wherein the east line of an edge tile formed  
35 on said west perimeter is coupled to the west line of a core  
36 tile.

37

1        84. The tile based FPGA architecture of Claim 83 wherein  
2 each edge tile includes a general interconnect structure,  
3 wherein said plurality of horizontal long lines, said  
4 plurality of vertical long lines, and said at least two lines  
5 are programmably connected to said general interconnect  
6 structure.

7

8        85. The tile based FPGA architecture of Claim 84 further  
9 including at least one pad, wherein said at least one pad is  
10 programmably connected to the general interconnect structure  
11 of an edge tile.

12

13        86. The tile based FPGA architecture of Claim 85 further  
14 including a plurality of pads, wherein each pad is  
15 programmably connected to the general interconnect structure  
16 of an edge tile.

17

18        87. The tile based FPGA architecture of Claim 85 wherein  
19 said at least one pad is programmably connected to the general  
20 interconnect structure via a pad interconnect structure.

21

22        88. The tile based FPGA architecture of Claim 87 wherein  
23 both said general interconnect structure and said pad  
24 interconnect structure include programmable interconnection  
25 points (PIPs).

26

27        89. The tile based FPGA architecture of Claim 88 wherein  
28 said pad interconnect structure provides more PIPs than said  
29 general interconnect structure.

30

31        90. The tile based FPGA architecture of Claim 89 wherein  
32 said pad interconnect structure is substantially fully  
33 pipulated.

34

35        91. The tile based FPGA architecture of Claim 90 wherein  
36 said general interconnect structure is sparsely pipulated.

37

1        92. A method of forming a tile based FPGA architecture,  
2 said method comprising the steps of:  
3        forming a configurable logic block matrix in a core tile;  
4        forming a programmable routing matrix in said core tile;  
5        coupling said configurable logic block matrix and said  
6        programmable routing matrix;  
7        coupling said configurable logic block matrix to a  
8        configurable logic block matrix in an adjacent core  
9        tile;  
10      coupling said programmable routing matrix to a  
11      programmable routing matrix in another core tile.  
12

13      93. The method of forming a tile based FPGA architecture  
14 of Claim 92 wherein said another core tile is adjacent said  
15 programmable routing matrix in said core tile.

16      94. The method of forming a tile based FPGA architecture  
17 of Claim 92 wherein said another core tile is not adjacent  
18 said programmable routing matrix in said core tile.  
20

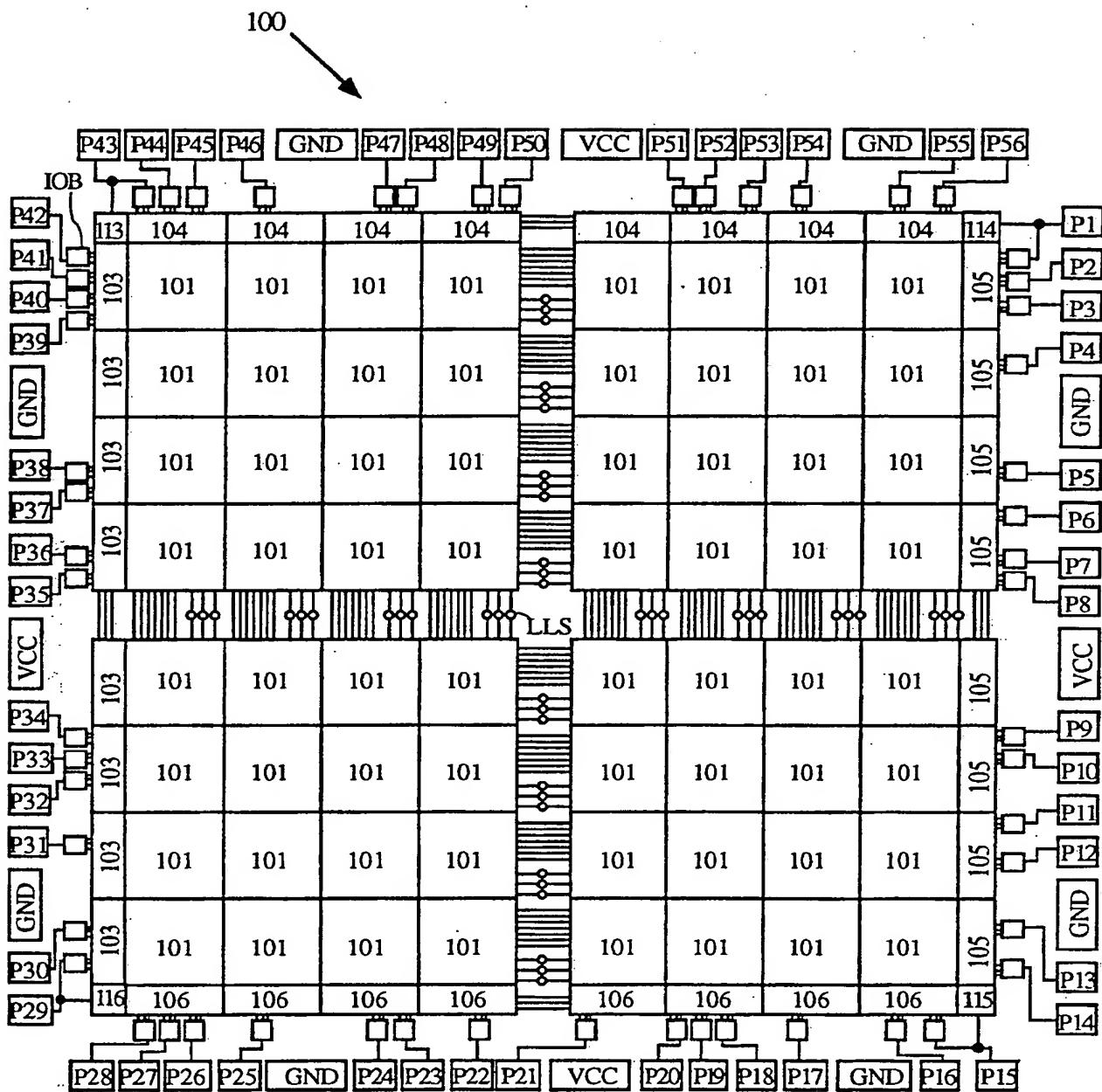


Fig. 1

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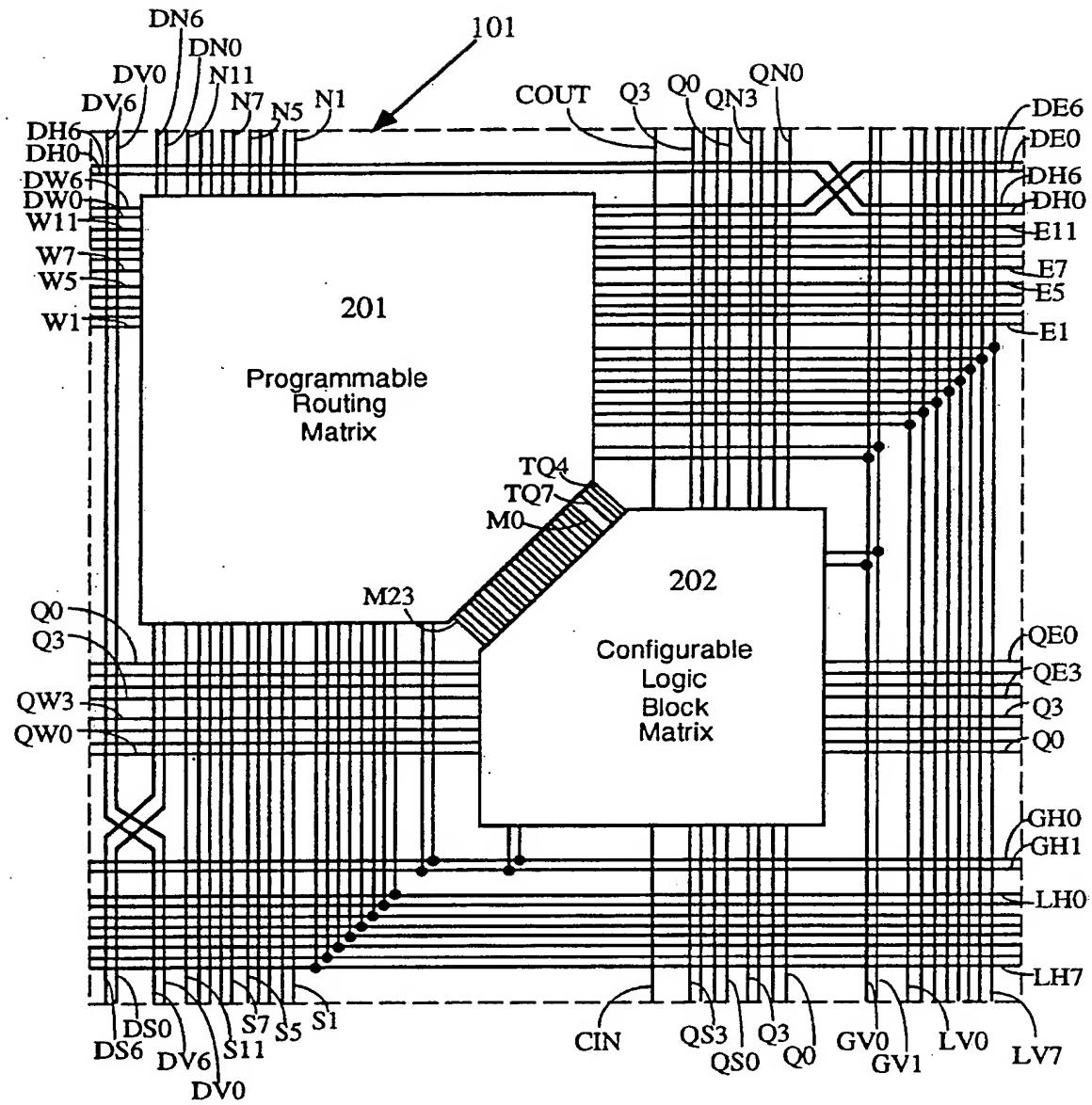
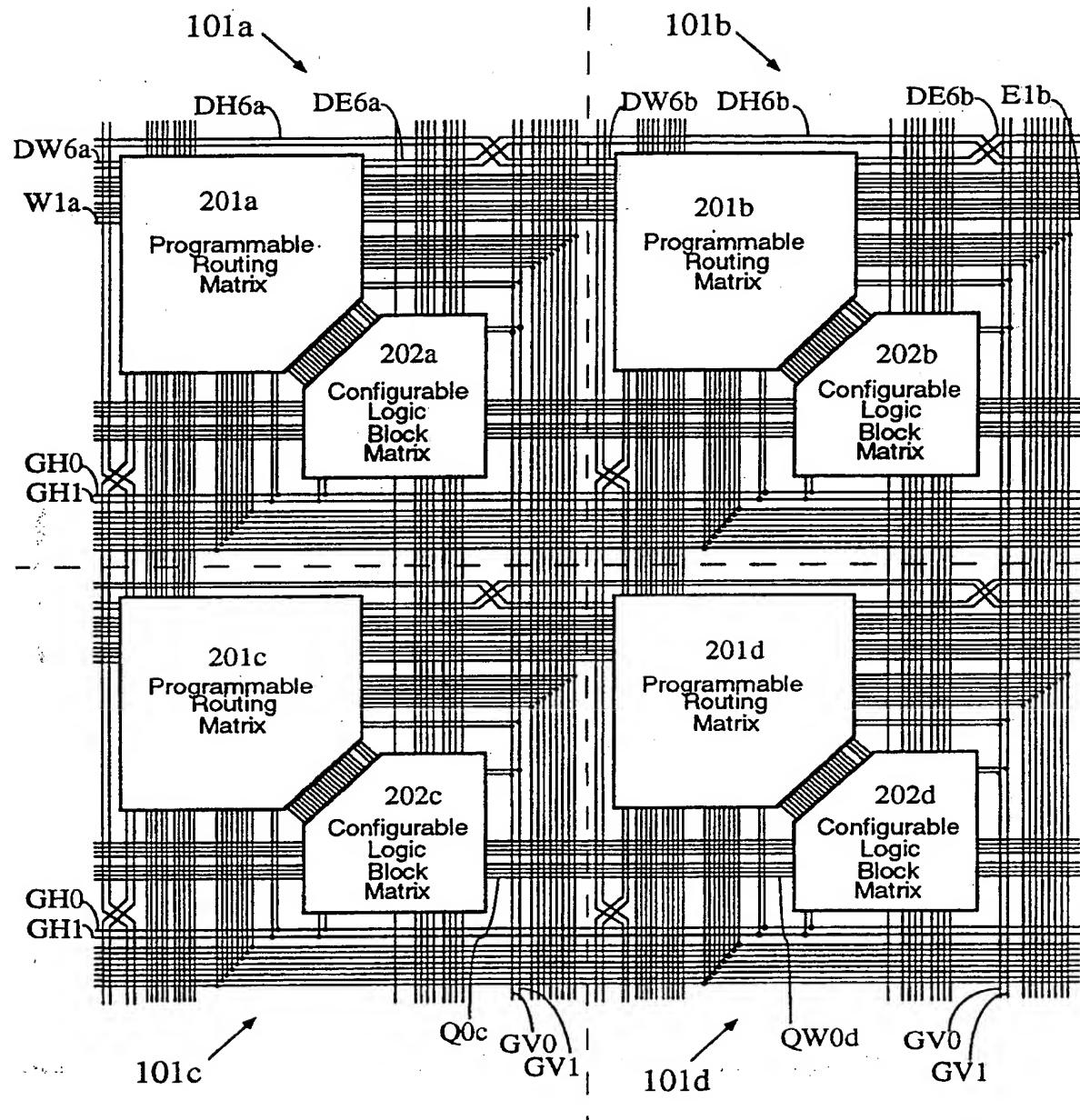


Fig. 2A

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**Fig. 2B**

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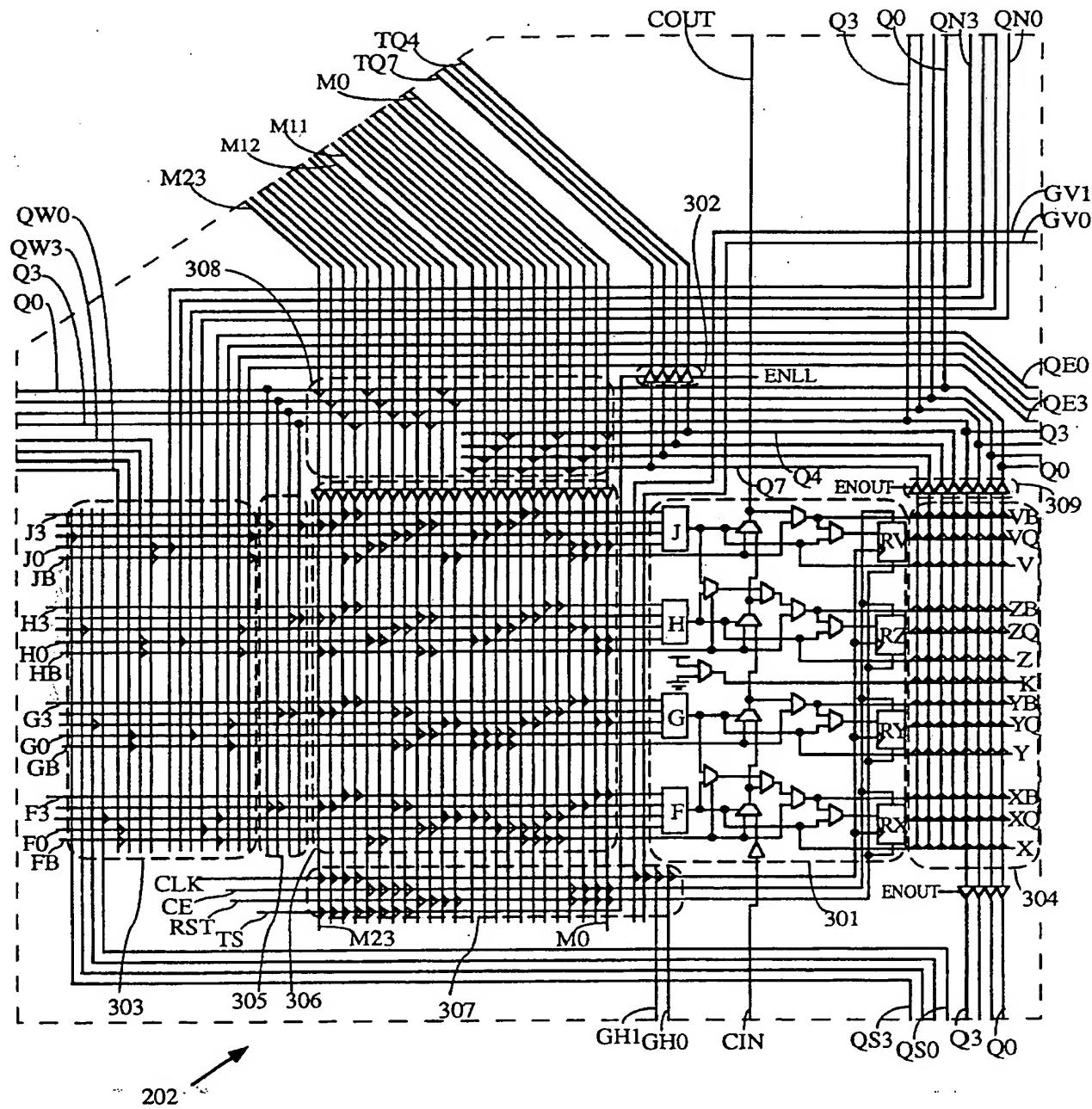


Fig. 3A

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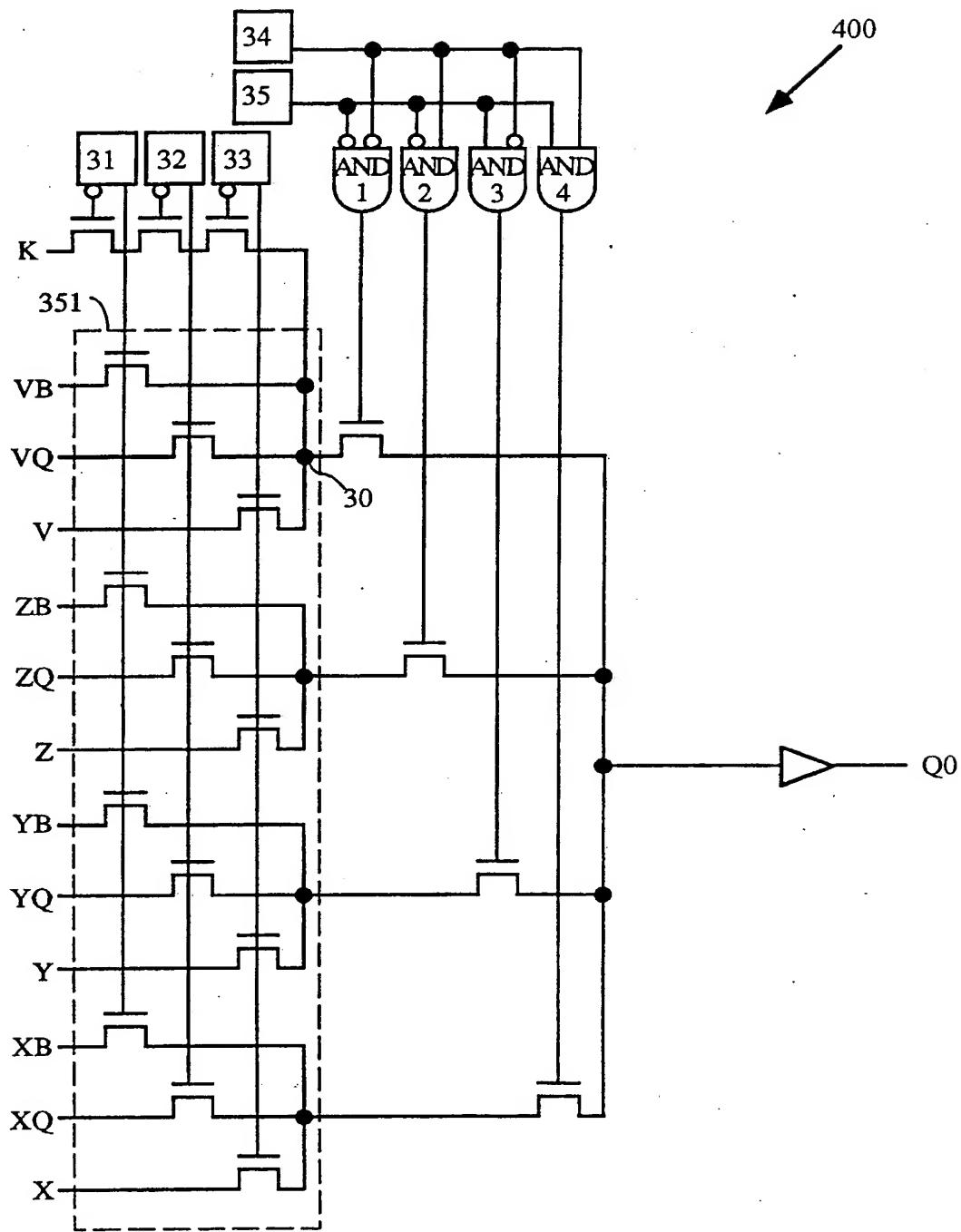


Fig. 3B

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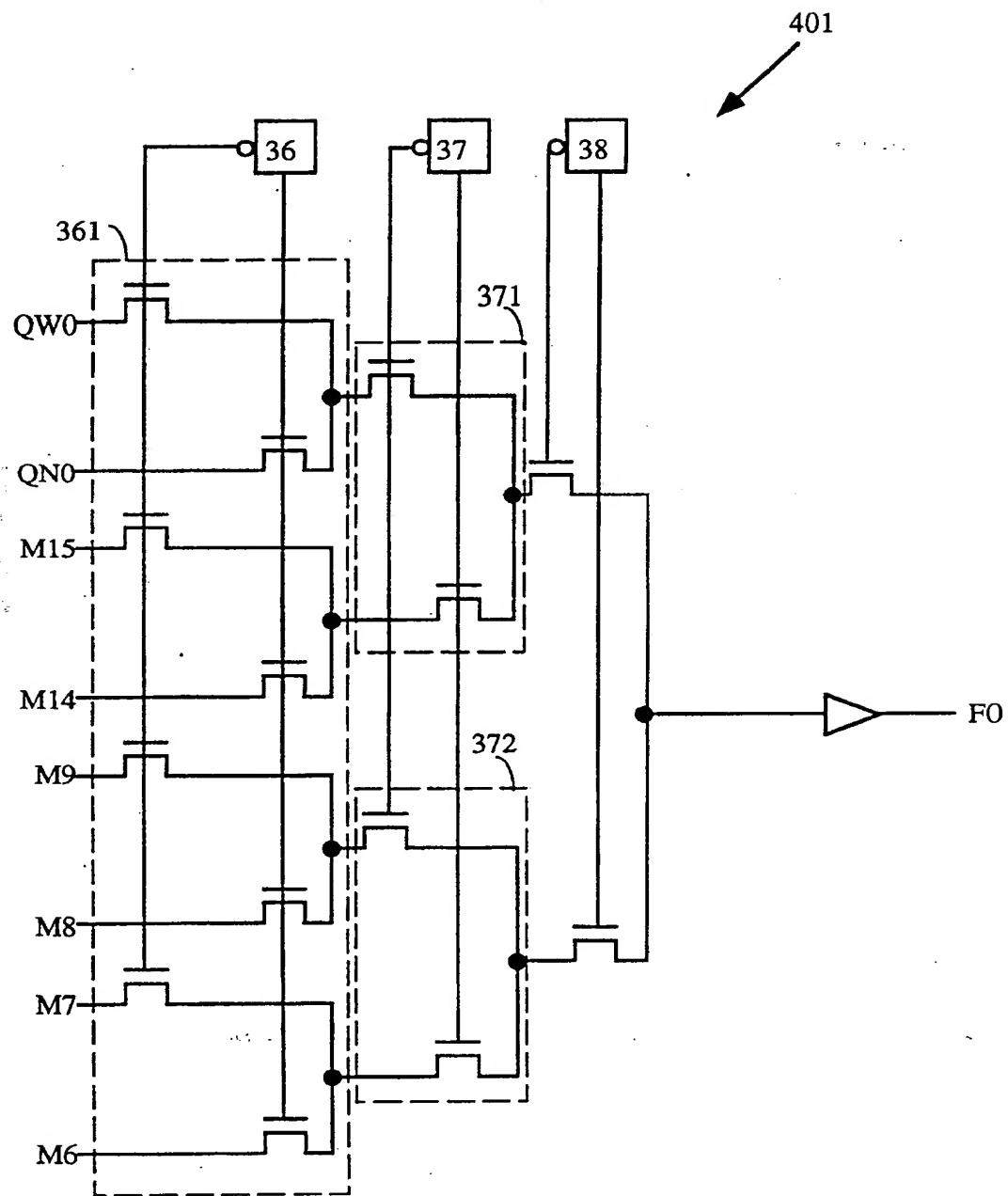


Fig. 3C

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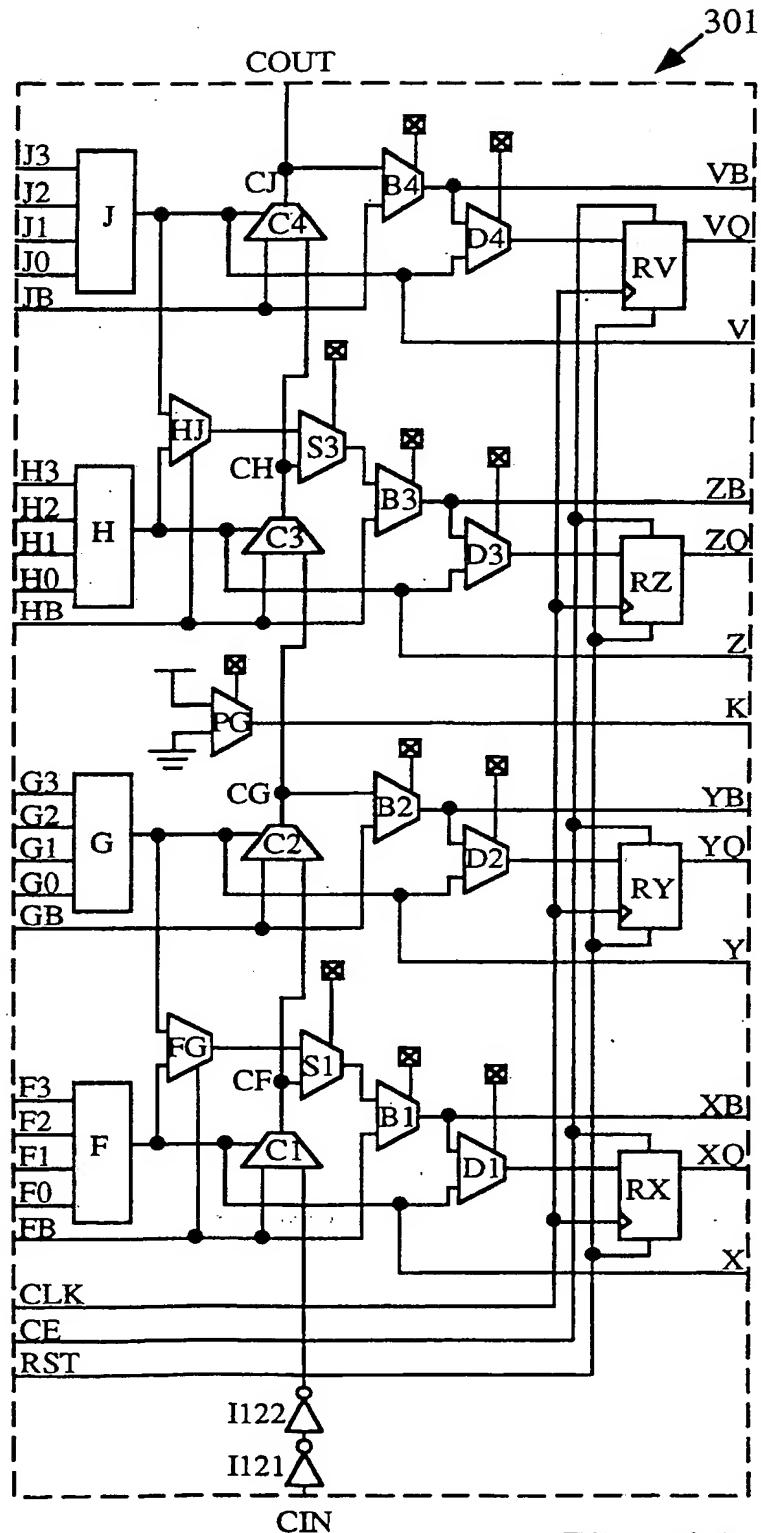
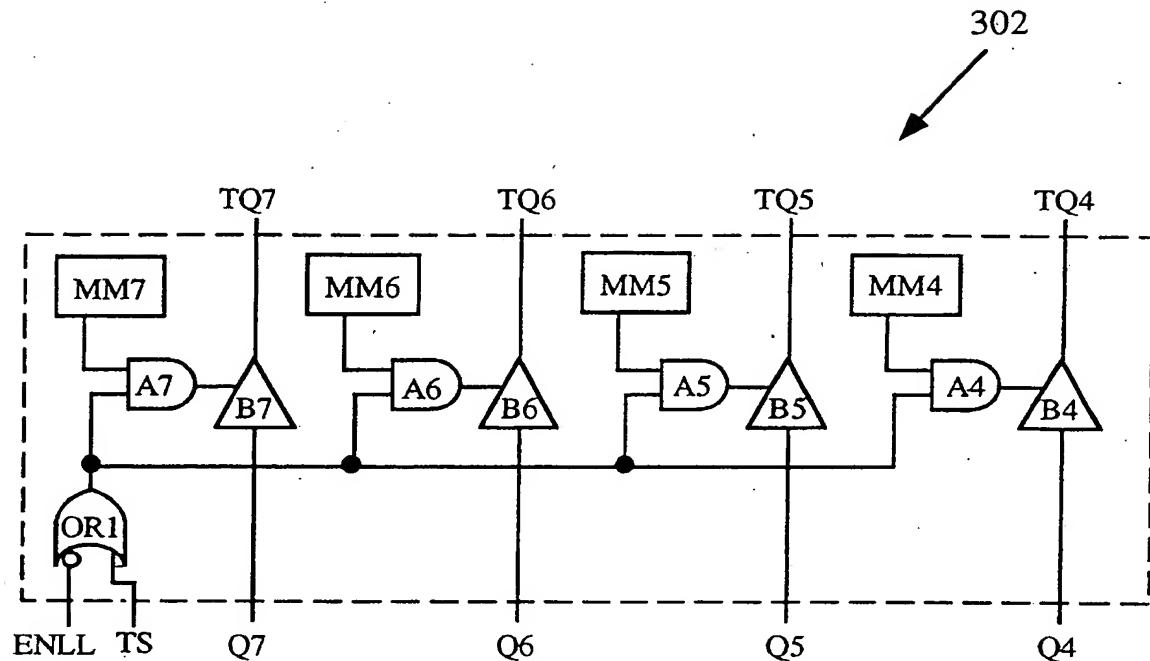
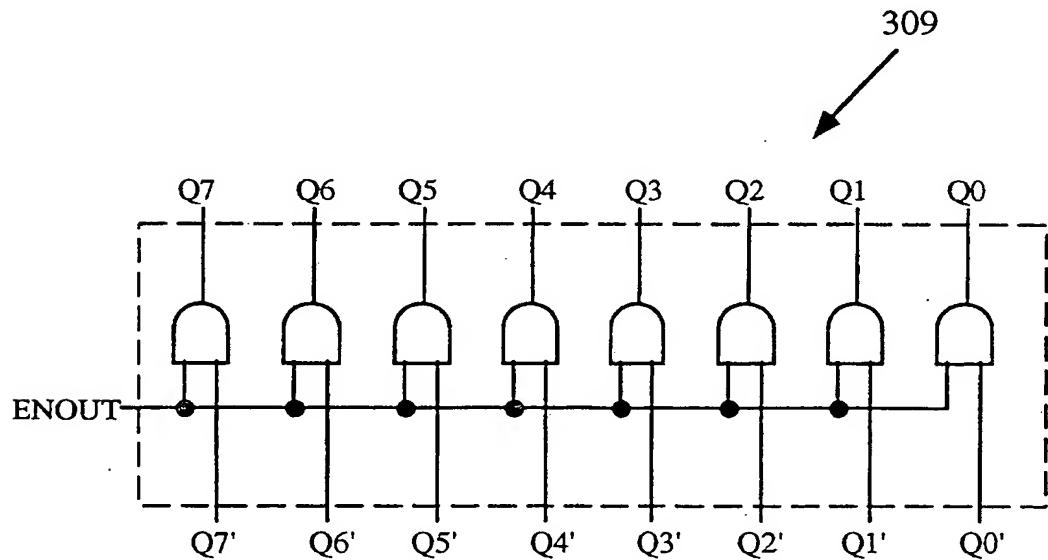


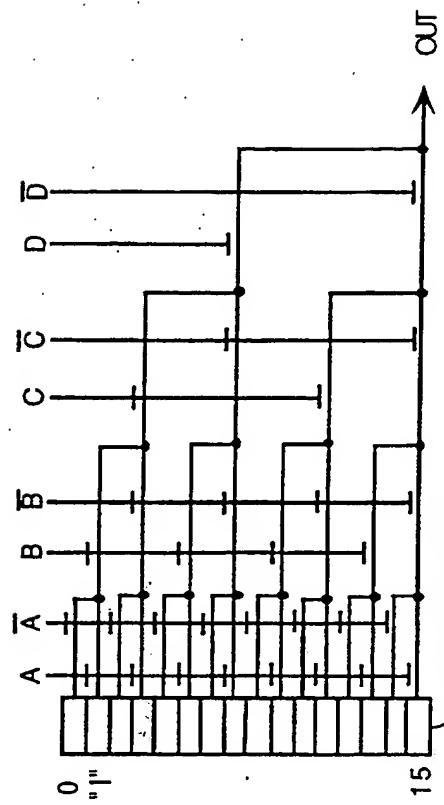
Fig. 4A

7/26  
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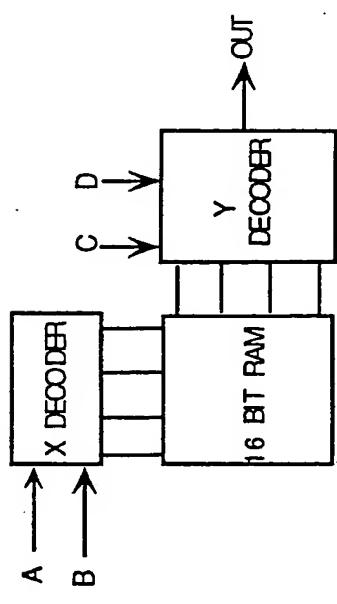
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**Fig. 4B****Fig. 4C**

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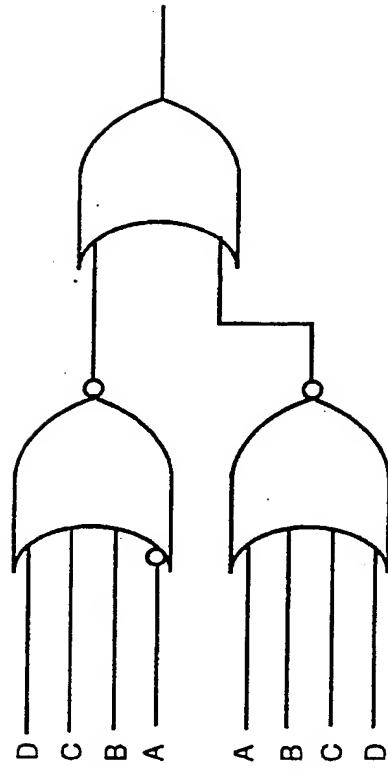
**Fig. 4E**  
Prior Art



**Fig. 4D**  
Prior Art

	C	0	1	1	0
A	0	1	0	0	0
D	0	0	0	0	0
B	1	0	0	0	0
	1	1	0	0	0
	0	1	0	0	0

**Fig. 4F**  
Prior Art



**Fig. 4G**  
Prior Art

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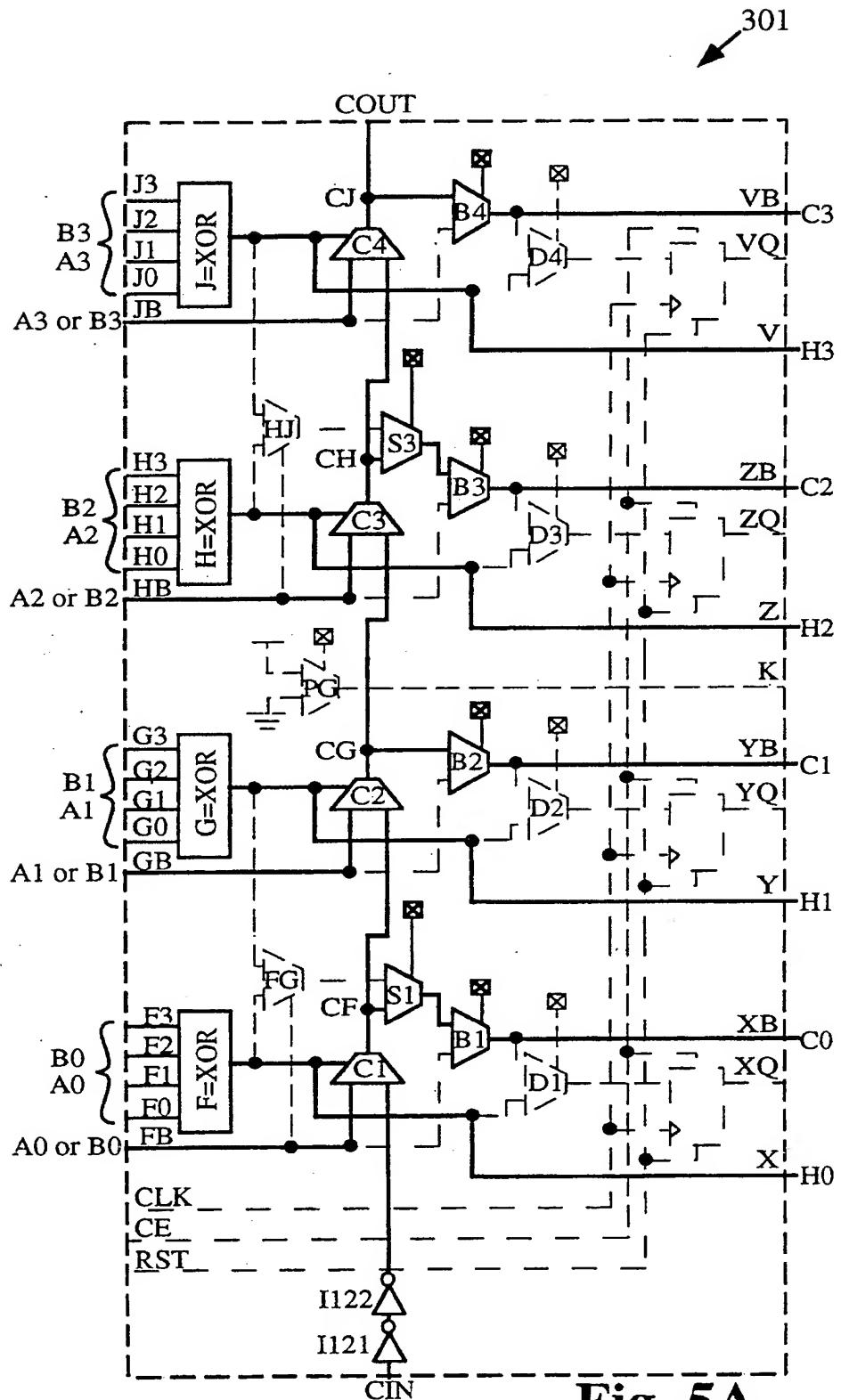


Fig. 5A

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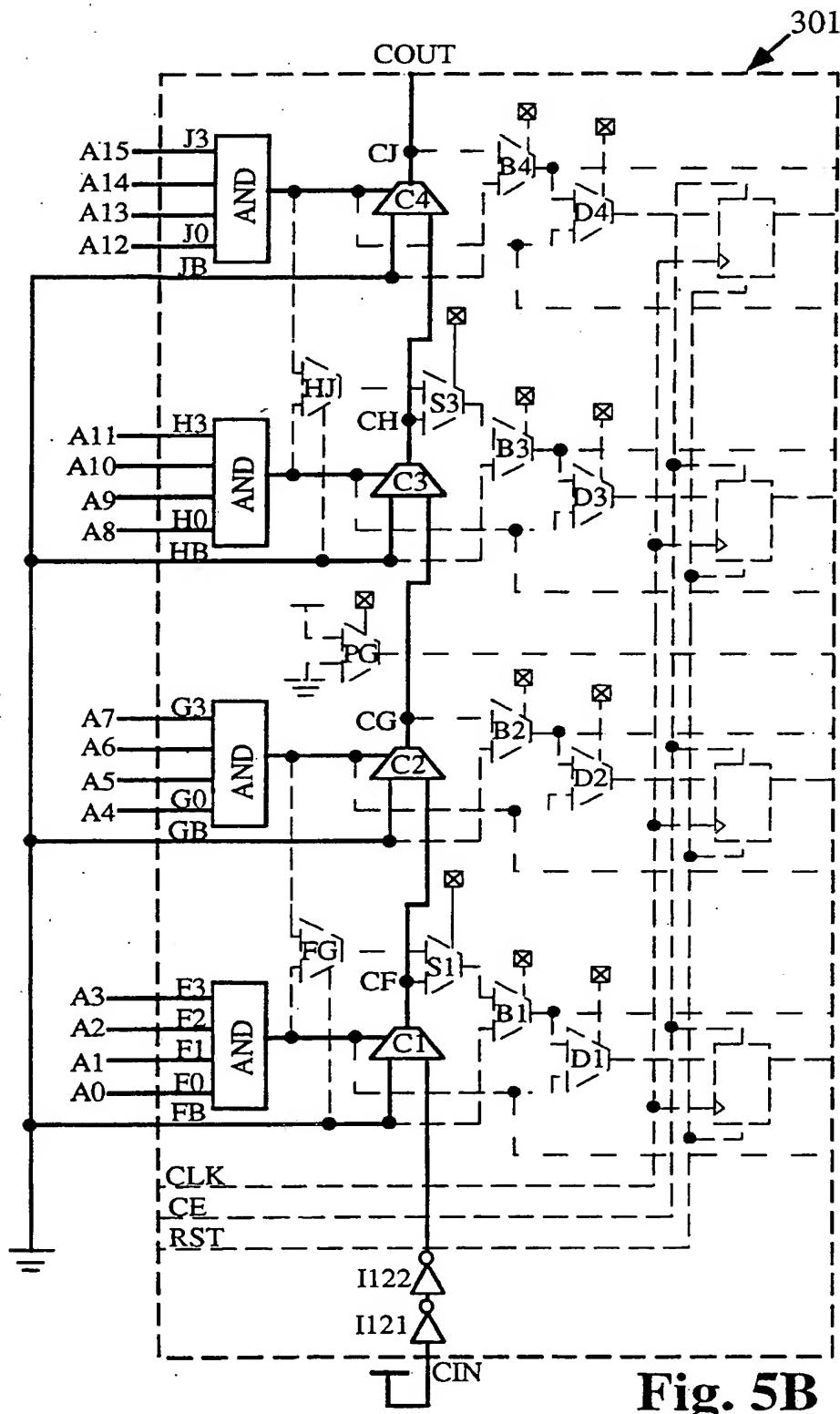


Fig. 5B

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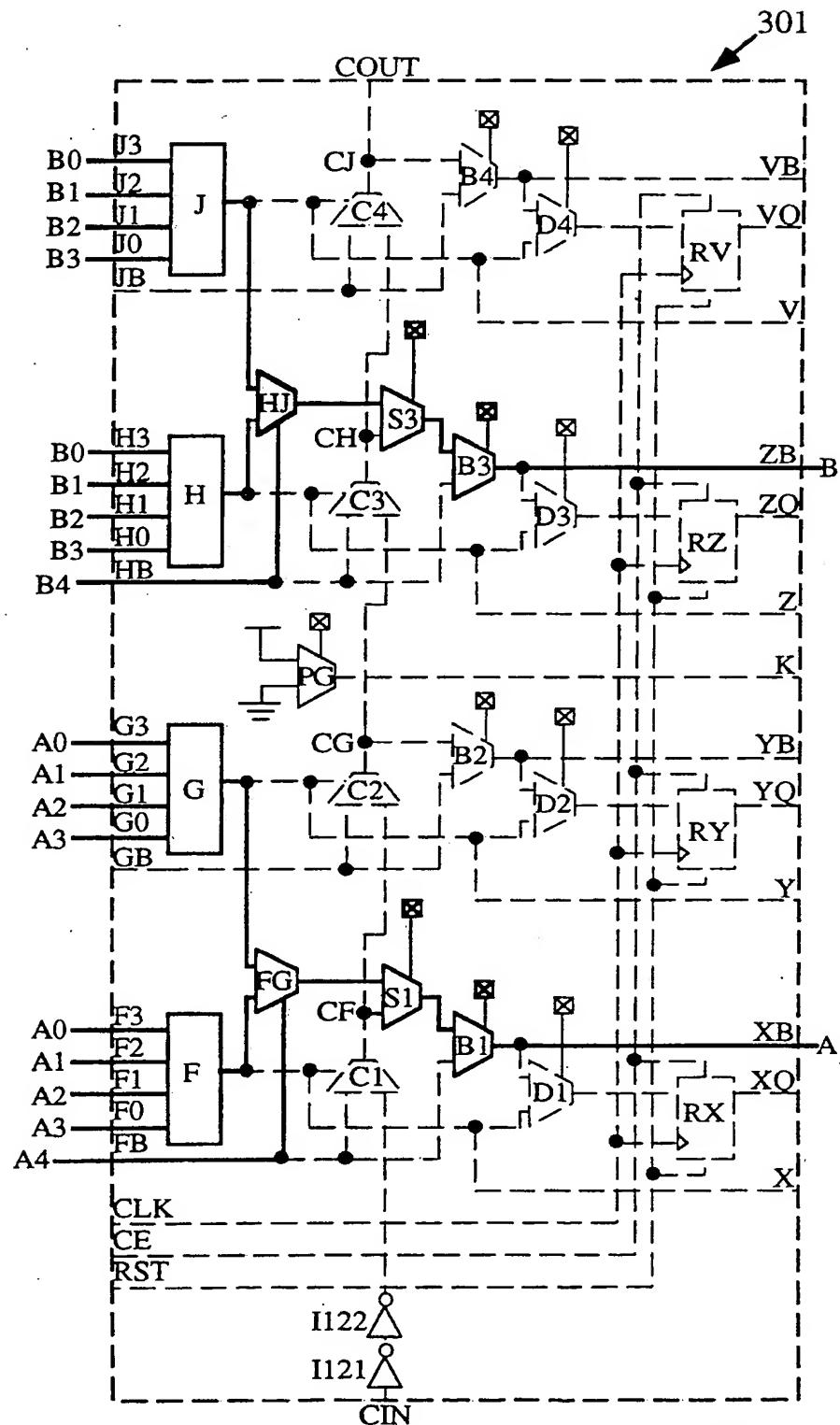
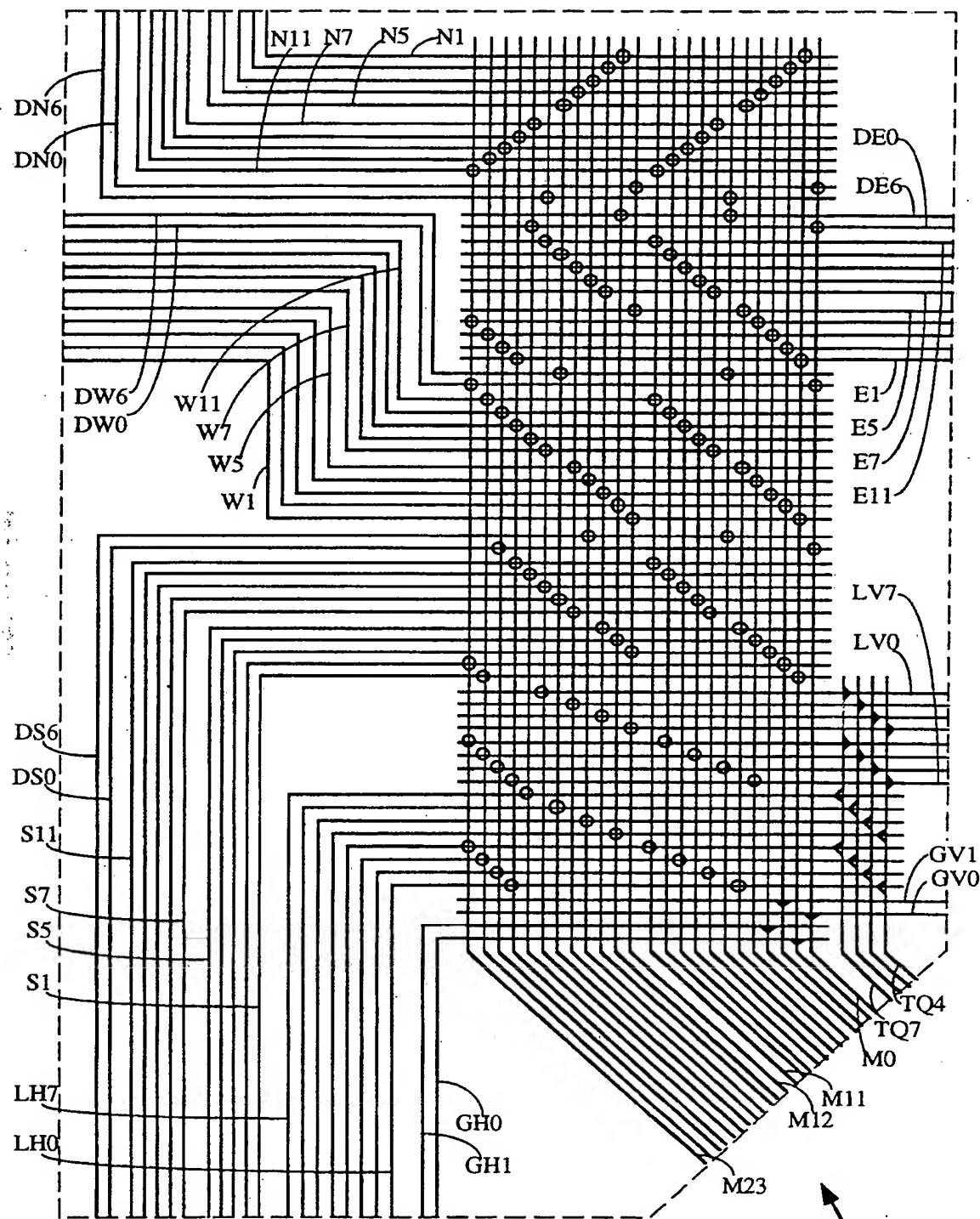


Fig. 5C

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**Fig. 6**

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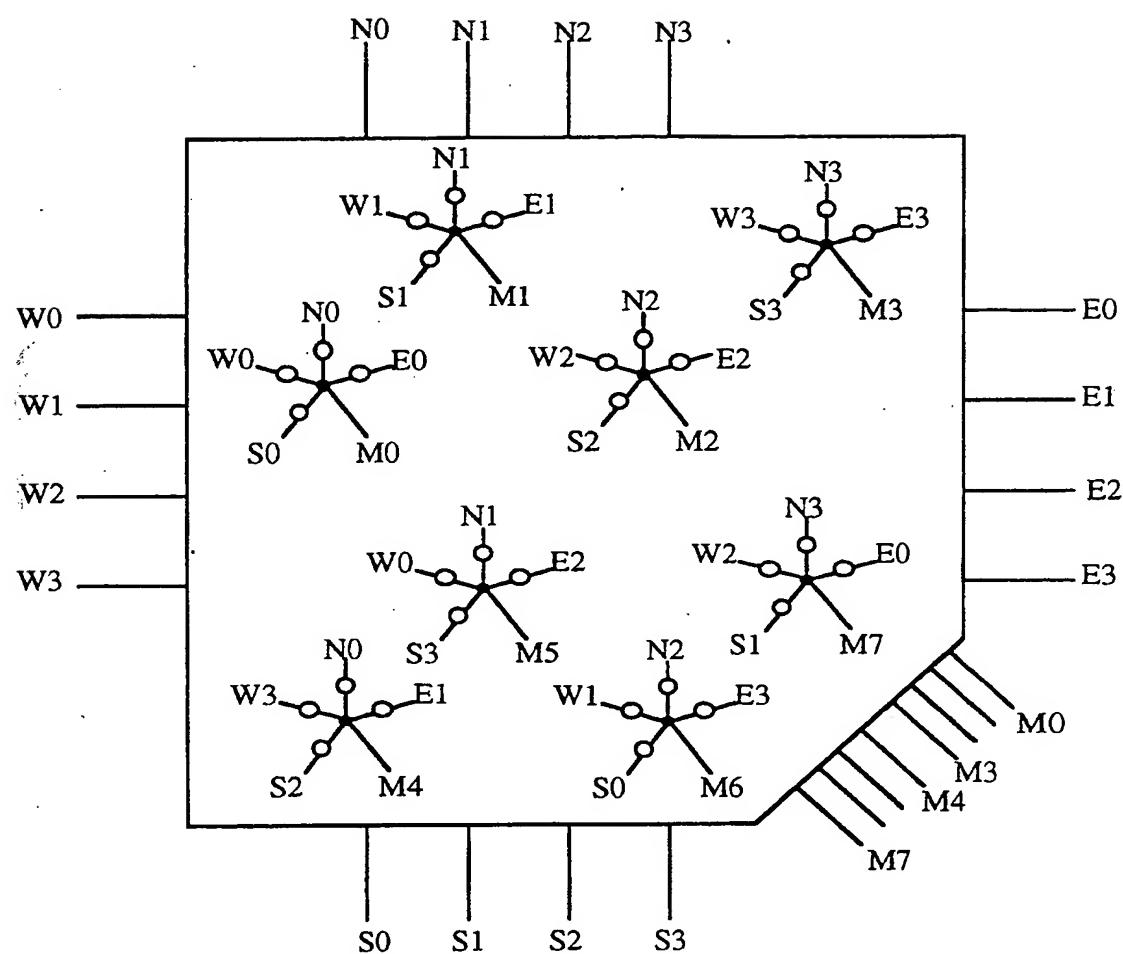
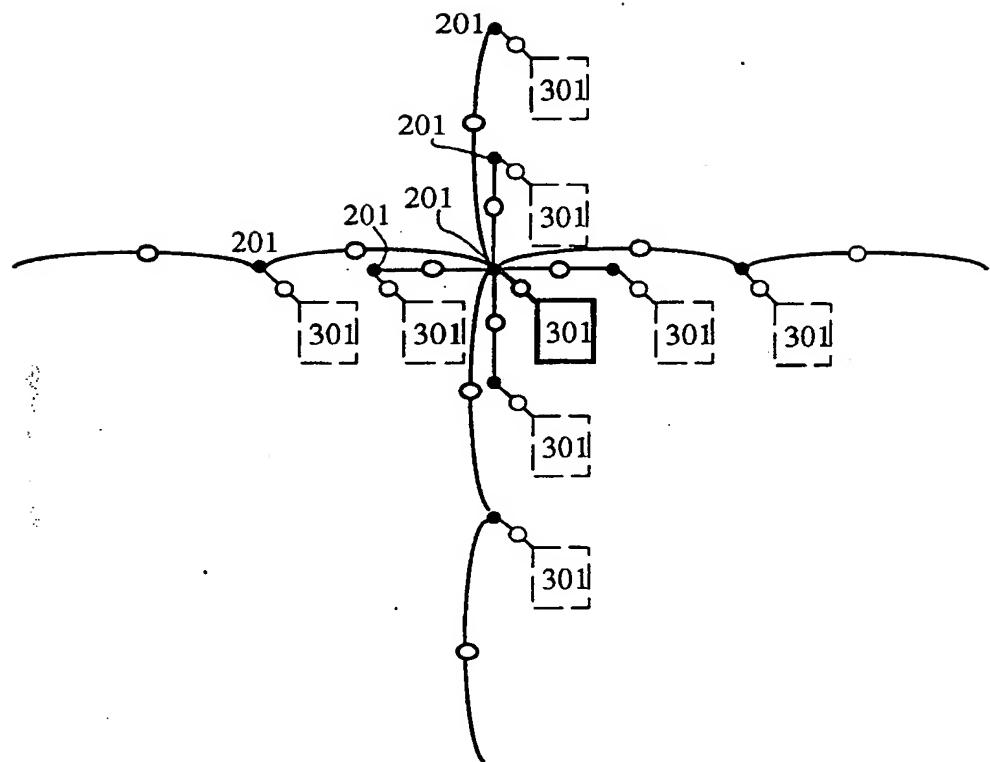


Fig. 7A

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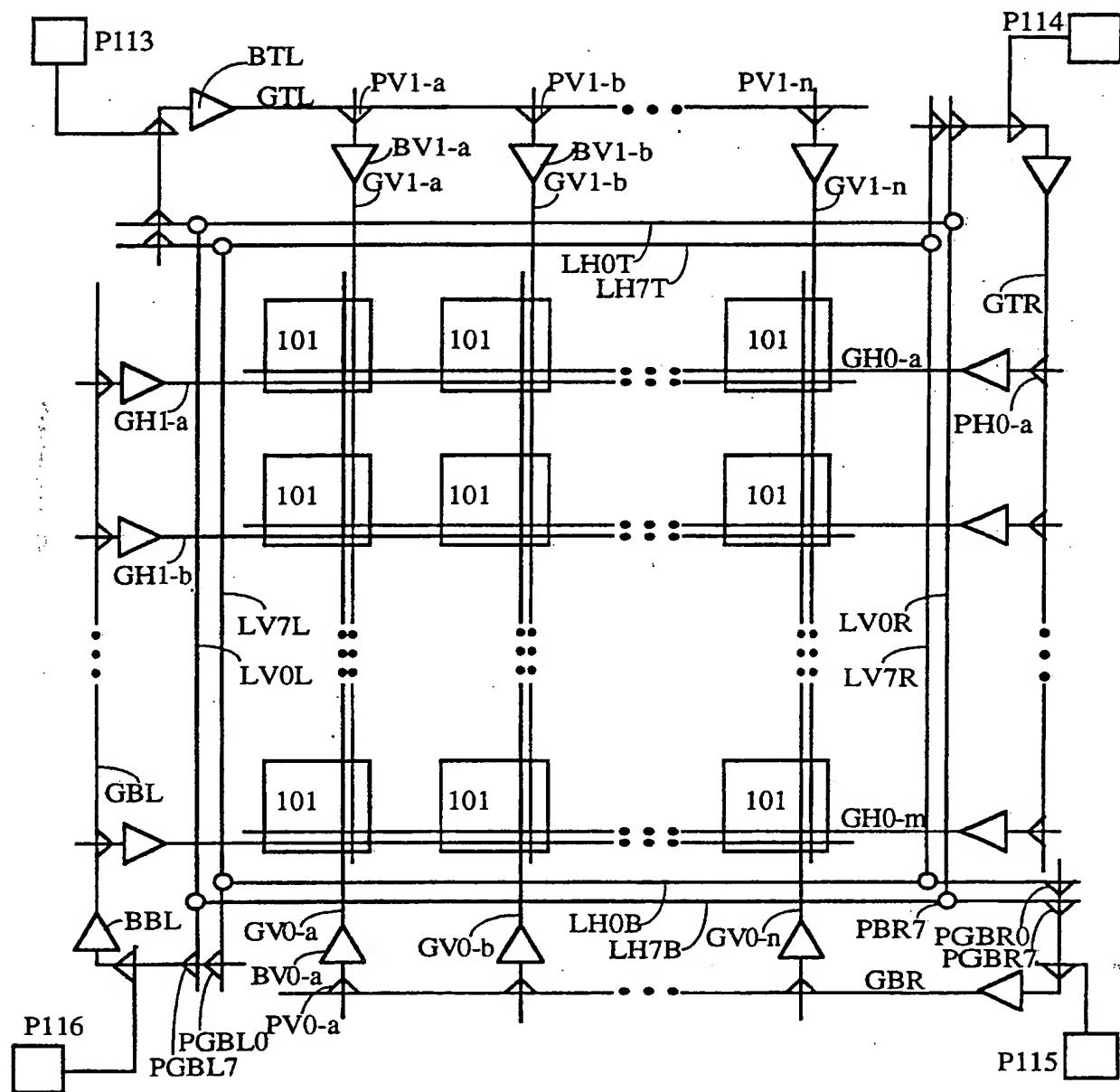


**Fig. 7B.**

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**Fig. 8**

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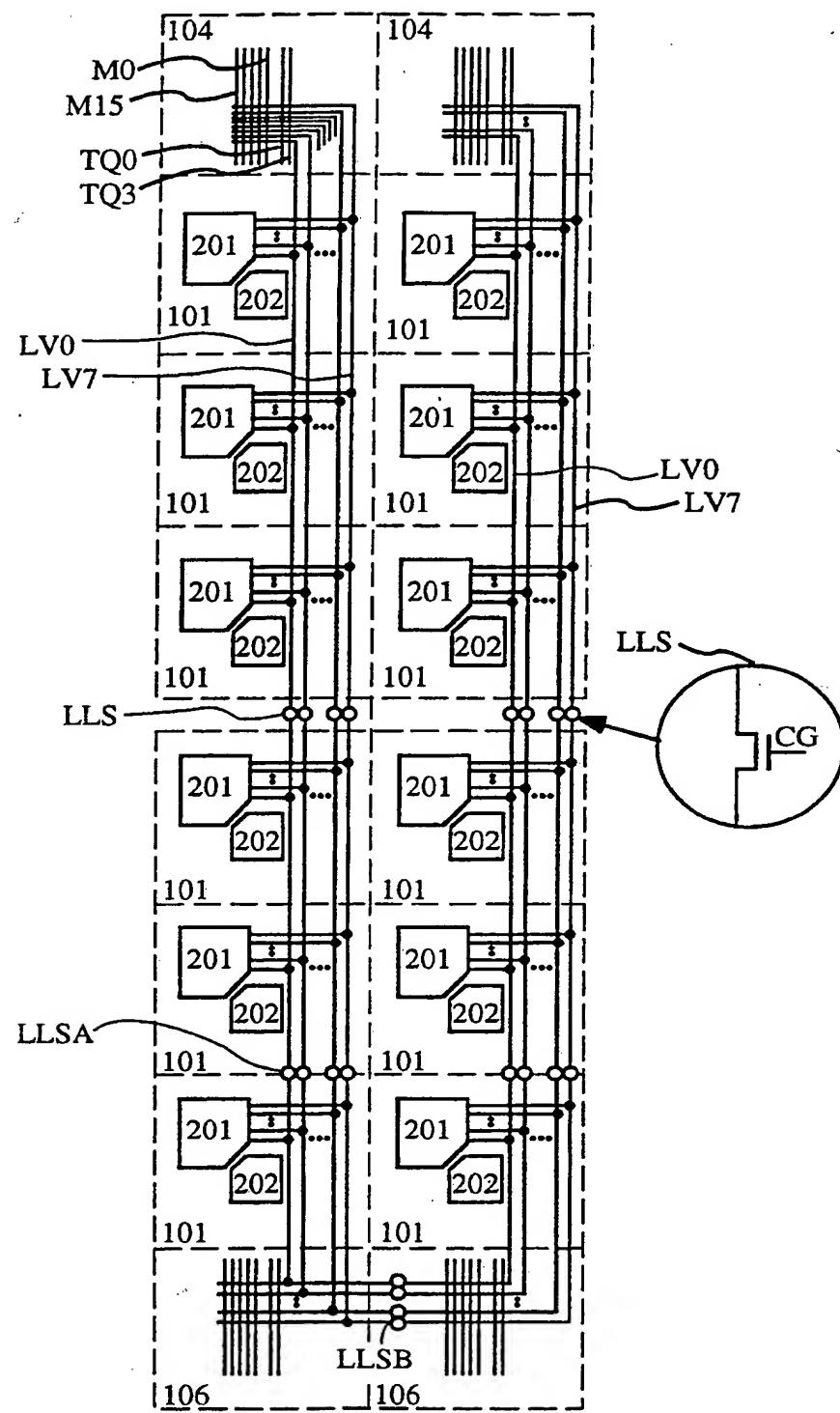


Fig. 9

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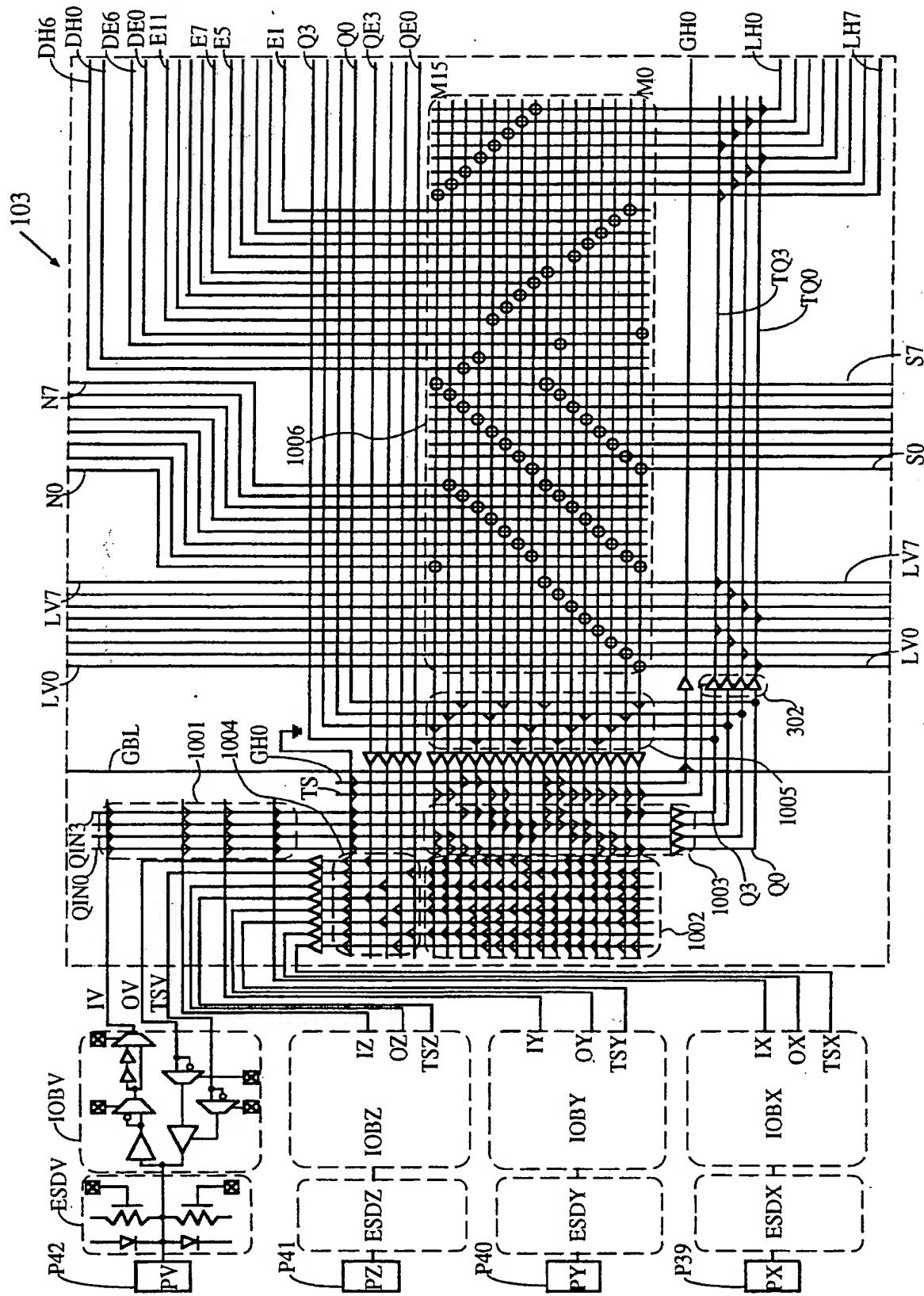


Fig. 10A

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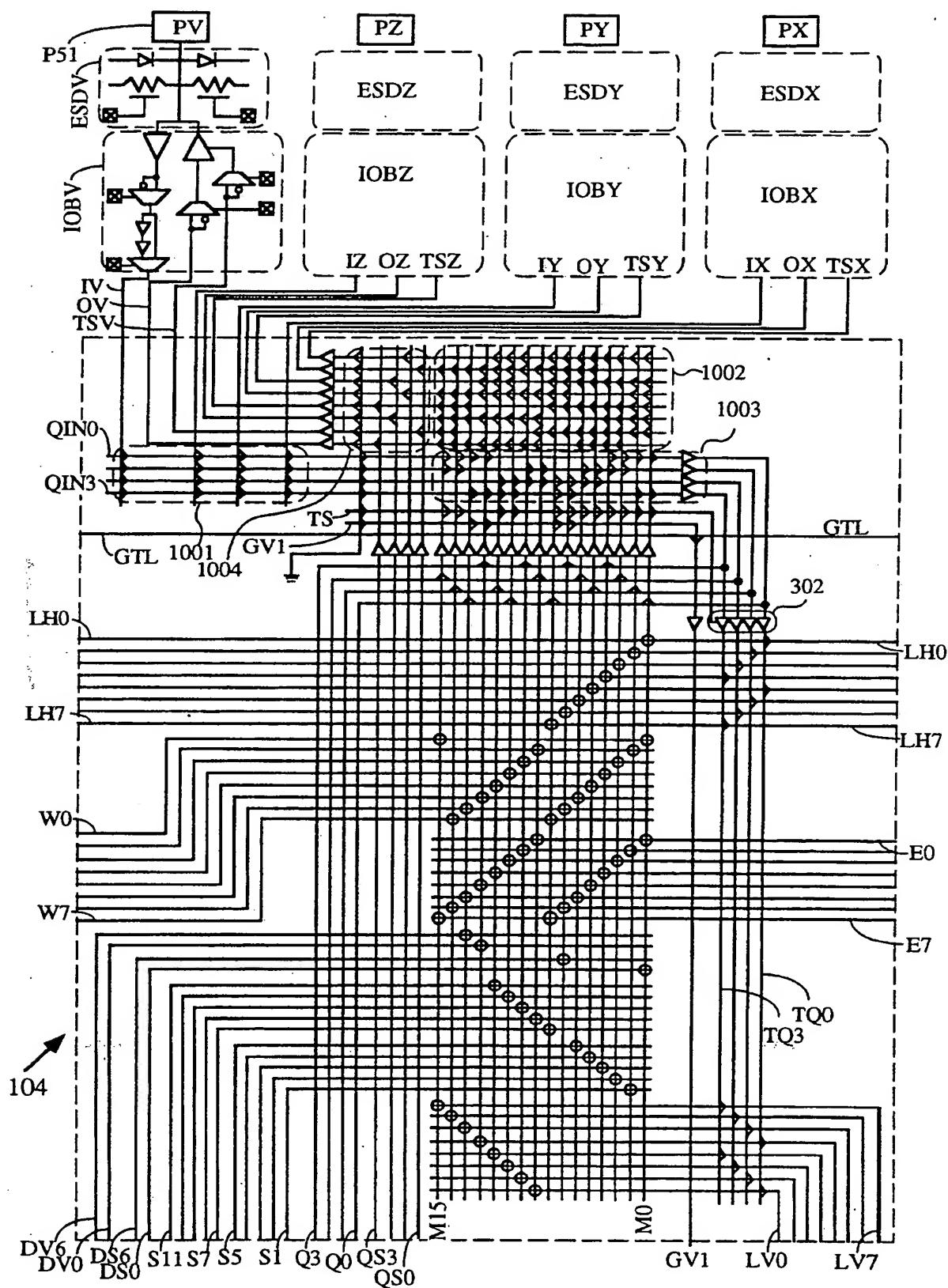


Fig. 10B

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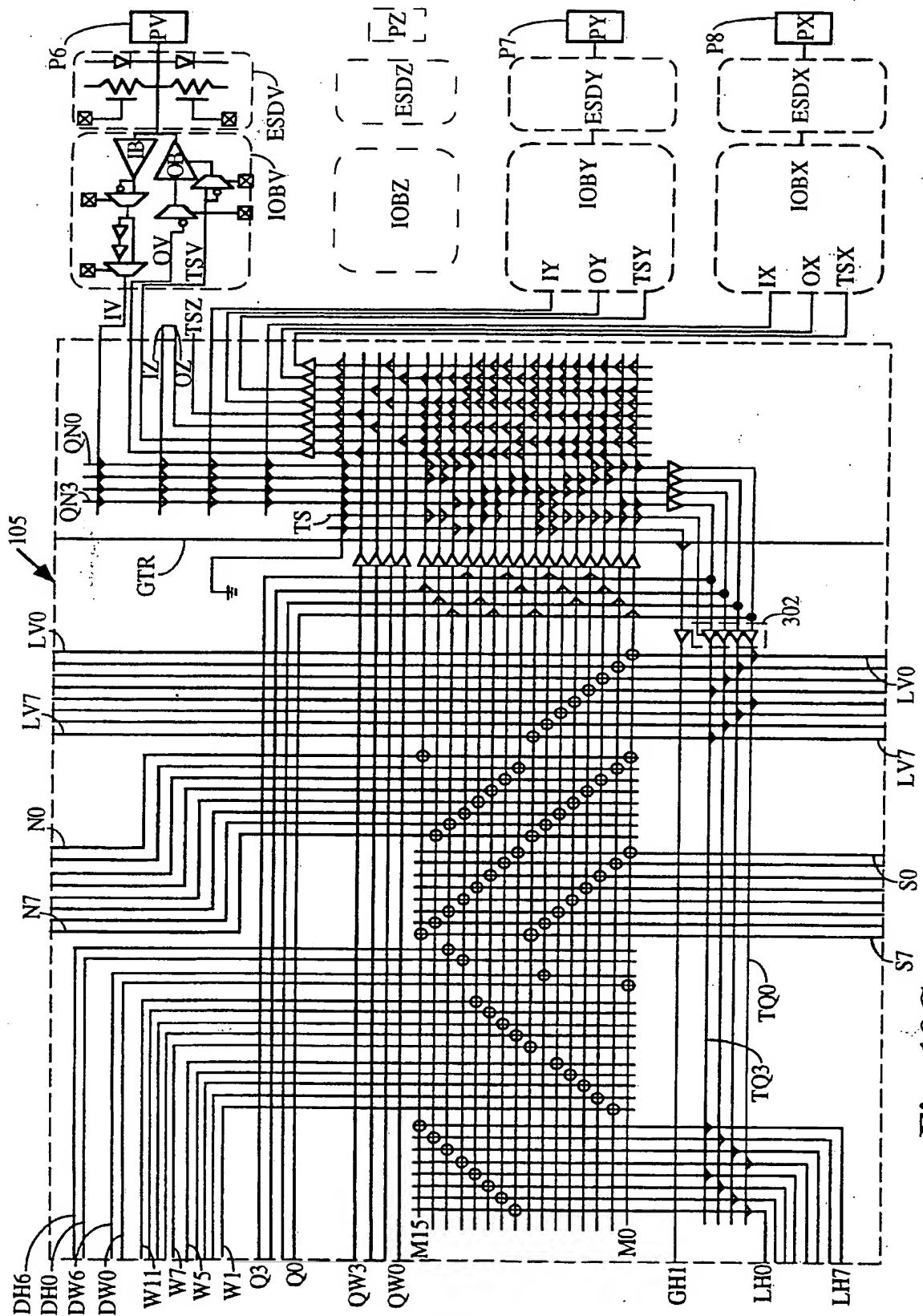
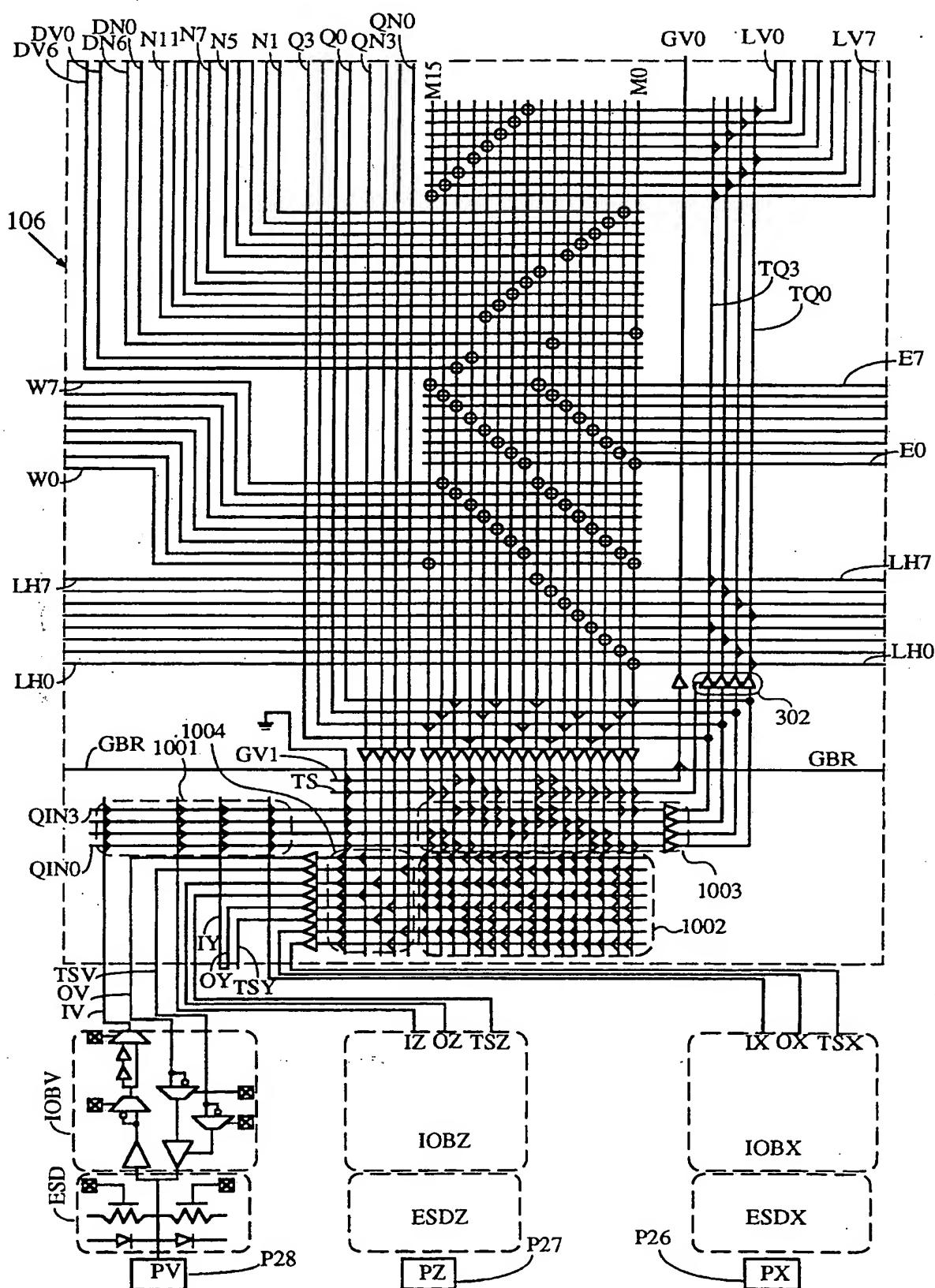


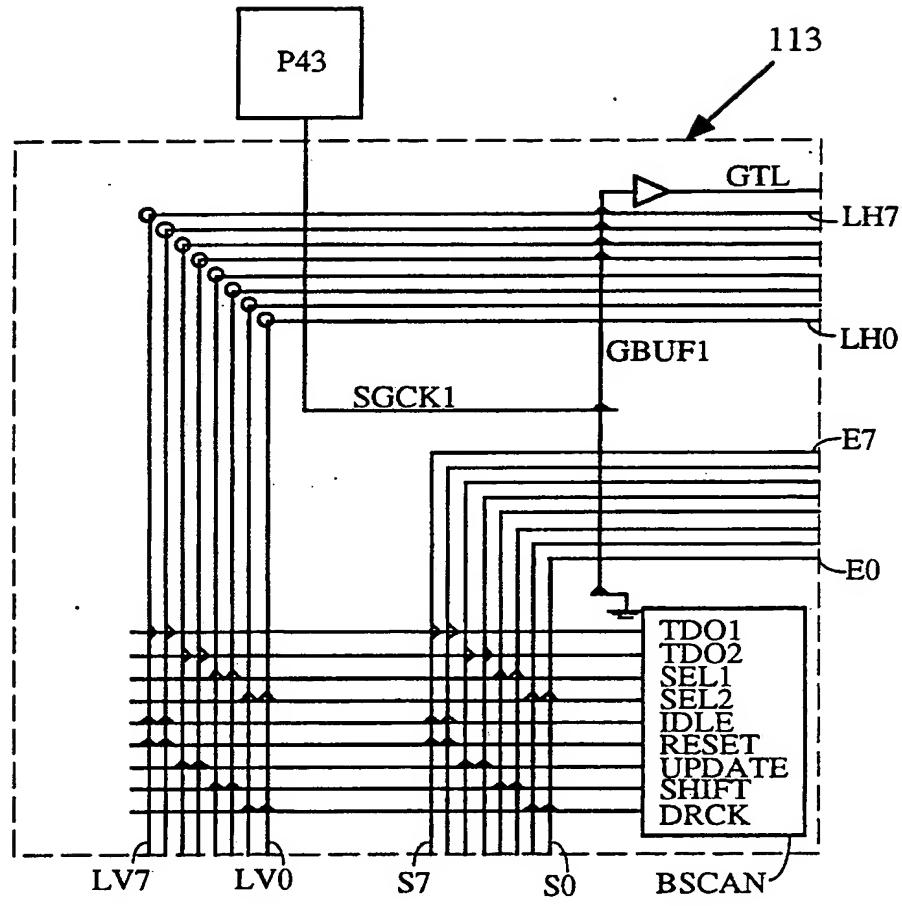
Fig. 10C

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**Fig. 10D**

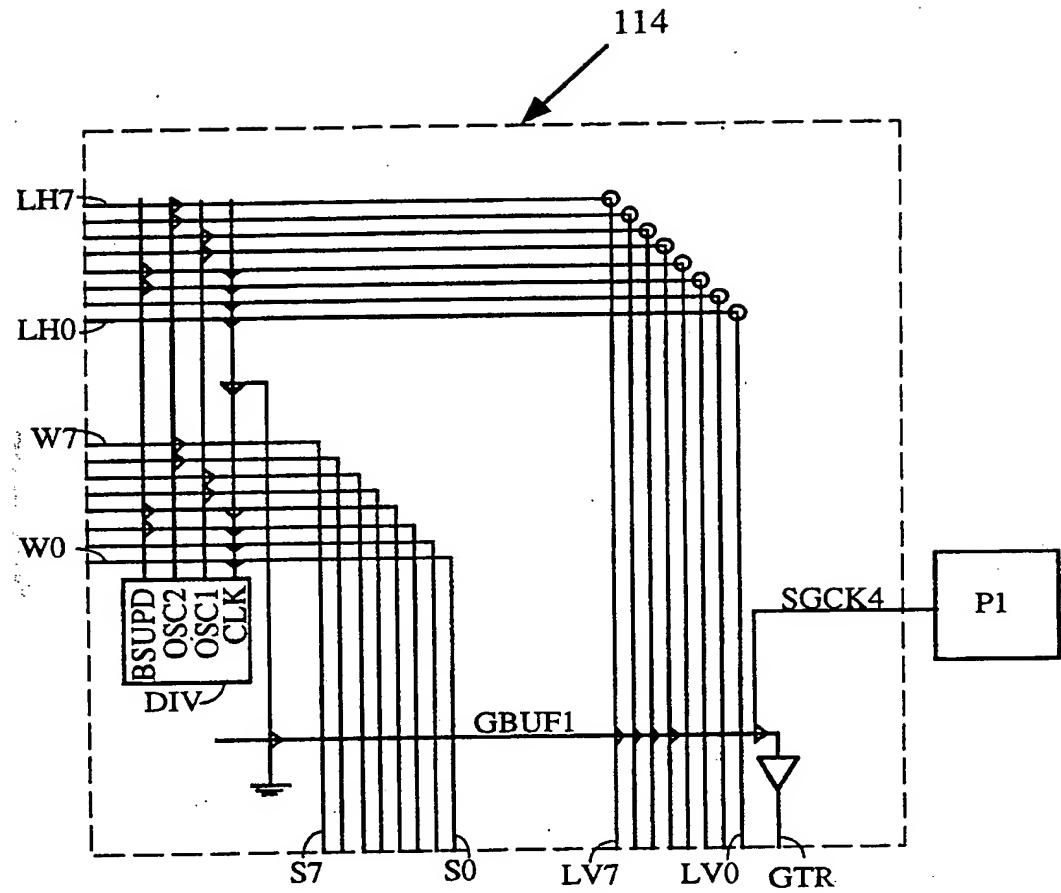
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**Fig. 11A**

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**Fig. 11B**

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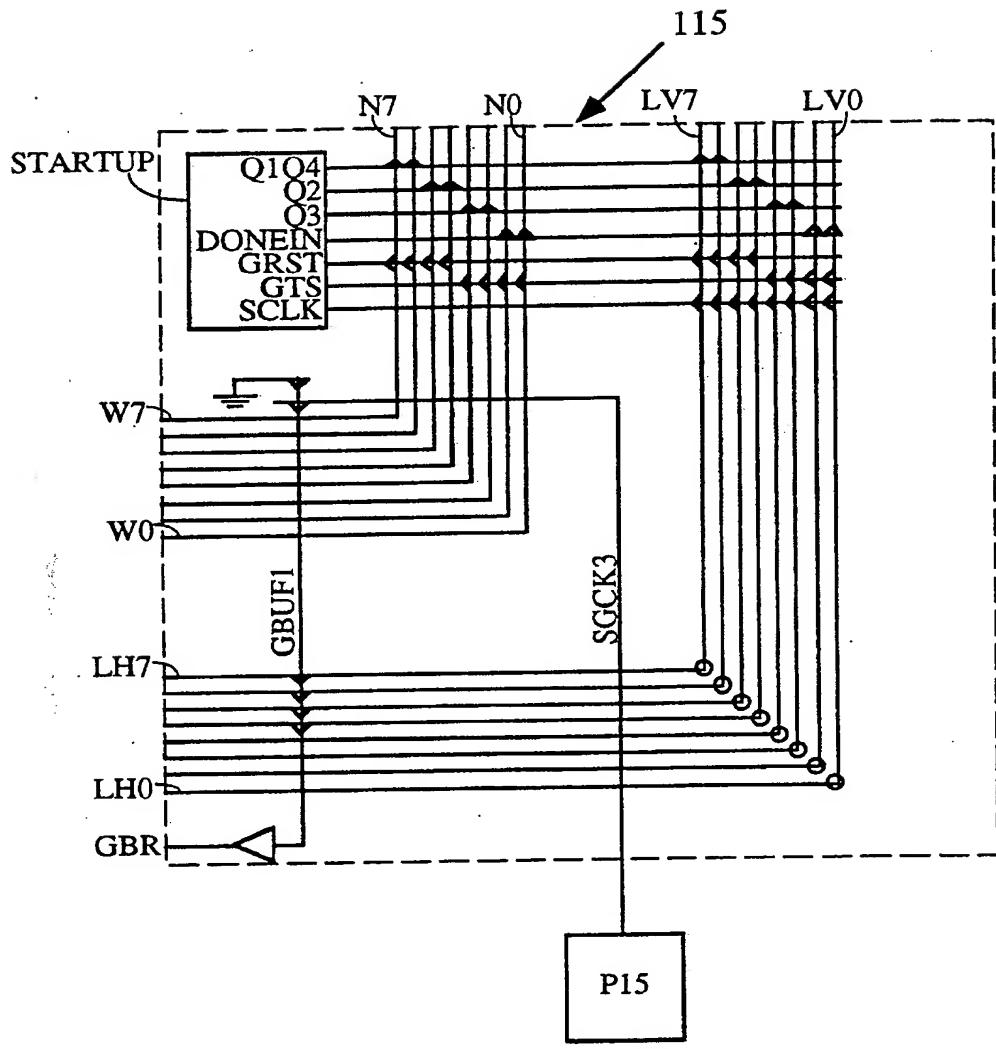


Fig. 11C

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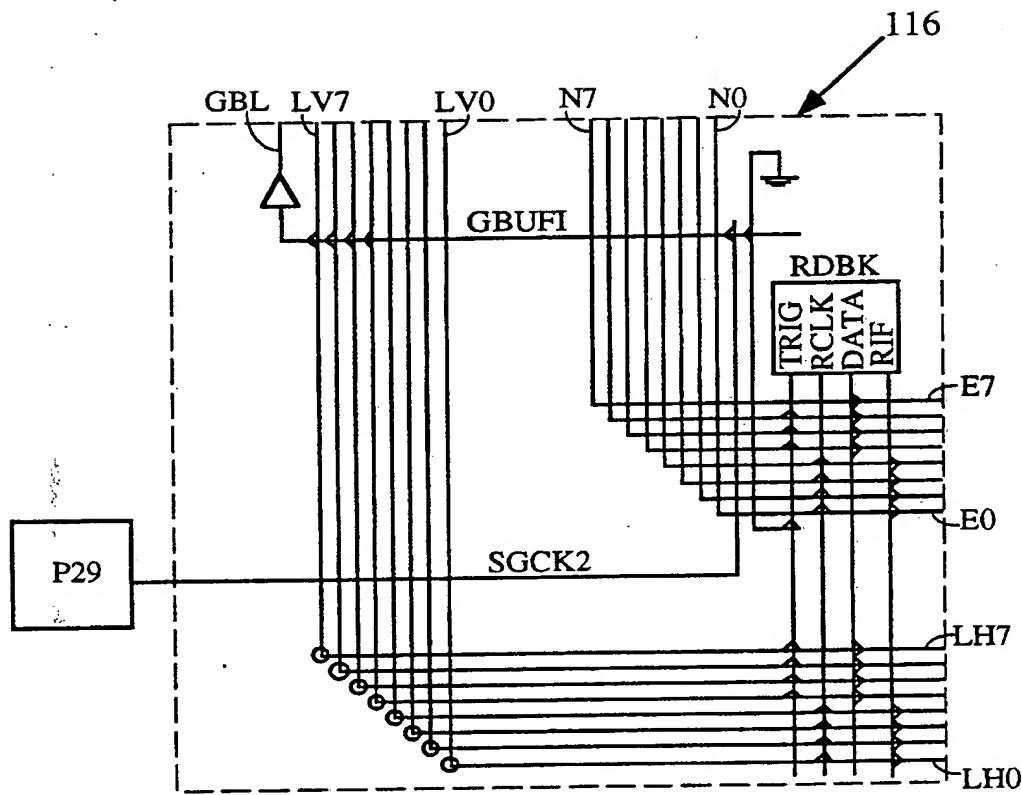


Fig. 11D

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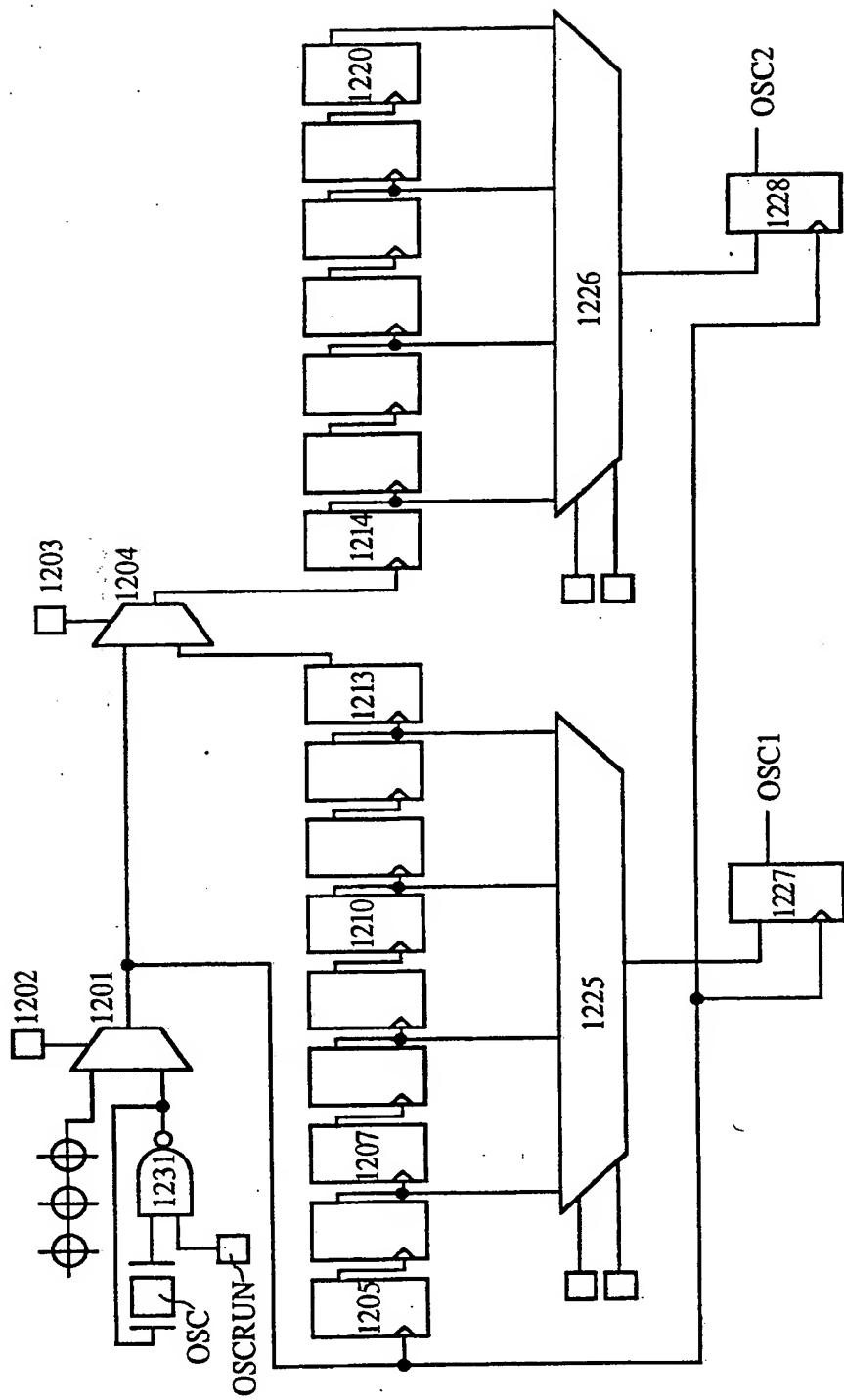


Fig. 12

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## INTERNATIONAL SEARCH REPORT

Int'l Application No. PCT/US 95/01554

A. CLASSIFICATION OF SUBJECT MATTER  
H 03 K 19/177

According to International Patent Classification (IPC) or to both national classification and IPC 6

## B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

H 01 L, H 03 K

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

## C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	EP, A, 0 461 798 (AMD) 18 December 1991 (18.12.91), the whole document. --	1-94
A	US, A, 5 260 610 (PEDERSEN et al.) 09 November 1993 (09.11.93), the whole document. --	1-94
A	US, A, 5 260 611 (CLIFF et al.) 09 November 1993 (09.11.93), the whole document. --	1-94
A	US, A, 5 241 224 (PEDERSEN et al.) 31 August 1993 (31.08.93), abstract; fig. 1-4D.	1,74, 78,79, 92

 Further documents are listed in the continuation of box C. Patent family members are listed in annex.

## \* Special categories of cited documents :

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Date of the actual completion of the international search  
23 May 1995

Date of mailing of the international search report

19.06.95

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European Patent Office, P.B. 5818 Patentlaan 2  
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## INTERNATIONAL SEARCH REPORT

-2-

International Application No  
PCT/US 95/01554

C.(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT		
Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	US, A, 5 280 202 (CHAN et al.) 18 January 1994 (18.01.94), abstract; figs.. ----	1,74, 78,79, 92

**ANHANG**

zum internationalen Recherchenbericht über die internationale Patentanmeldung Nr.

**ANNEX**

to the International Search Report to the International Patent Application No.

**ANNEXE**

au rapport de recherche international relatif à la demande de brevet international n°

PCT/US 95/01554 SAE 104868

In diesem Anhang sind die Mitglieder der Patentfamilien der im obengenannten internationalen Recherchenbericht angeführten Patentdokumente angegeben. Diese Angaben dienen nur zur Orientierung und erfolgen ohne Gewähr.

This Annex lists the patent family members relating to the patent documents cited in the above-mentioned international search report. The Office is in no way liable for these particulars which are given merely for the purpose of information.

La présente annexe récite les membres de la famille de brevets relatifs aux documents de brevets cités dans le rapport de recherche international visé ci-dessus. Les renseignements fournis sont donnés à titre indicatif et n'engagent pas la responsabilité de l'Office.

In Recherchenbericht angeführtes Patentdokument Patent document cited in search report Document de brevet cité dans le rapport de recherche	Datum der Veröffentlichung Publication date Date de publication	Mitglied(er) der Patentfamilie Patent family member(s) Membre(s) de la famille de brevets	Datum der Veröffentlichung Publication date Date de publication
EP A2 461798	18-12-91	US A 5255203 EP A3 461798 JP A2 4233326 EP A2 415542 EP A3 415542 JP A2 3078317 JP A2 3079125 JP A2 3079126 US A 5212652 US A 5185706 US A 5231588 US A 5233539 US A 5329460 US A 5359536 US A 5260881	19-10-91 25-03-92 21-08-91 06-03-91 02-10-91 03-04-91 04-04-91 04-04-91 18-05-93 09-02-93 27-07-93 03-08-93 12-07-94 25-10-94 09-11-93
US A 5260610	09-11-93	EP A2 530985 EP A3 530985 JP A2 6318638 US A 5376844 US A 5260611 US A 5371422 EP A2 569137 EP A3 569137 JP A2 6053817	10-03-93 08-12-93 15-11-94 27-12-94 09-11-93 06-12-94 10-11-93 29-06-94 25-02-94
US A 5260611	09-11-93	EP A2 530985 EP A3 530985 JP A2 6318638 US A 5260610 US A 5376844 US A 5371422 EP A2 569137 EP A3 569137 JP A2 6053817	10-03-93 08-12-93 15-11-94 09-11-93 27-12-94 06-12-94 10-11-93 29-06-94 25-02-94
US A 5241224	31-08-93	EP A2 510815 EP A3 510815 JP A2 6291641 US A 5268598 US A 5384499 GB A0 9418435 GB A1 2281993	28-10-92 10-11-93 18-10-94 07-12-93 24-01-95 02-11-94 22-03-95
US A 5280202	18-01-94	JP T2 6505609 US A 5122685 WO A1 9216053 US A 5220213 US A 5396127 US A 5416367	23-06-94 16-06-92 17-09-92 15-06-93 07-03-95 16-05-95

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